

Battery-Backed I²C[™] Real-Time Clock/Calendar with SRAM, EEPROM and Protected EEPROM

Device Selection Table

Part Number	Protected EEPROM
MCP79410	Unprogrammed
MCP79411	EUI-48 [™]
MCP79412	EUI-64 [™]

Timekeeping Features:

- Real-Time Clock/Calendar (RTCC):
 - Hours, minutes, seconds, day of week, day, month, year
 - Leap year compensated to 2399
 - 12/24 hour modes
- Oscillator for 32.768 kHz Crystals:
- Optimized for 6-9 pF crystals
- On-Chip Digital Trimming/Calibration:
 - ±1 PPM resolution
 - ±129 PPM range
- Dual Programmable Alarms
- Versatile Output Pin:
 - Clock output with selectable frequency
 - Alarm output
 - General purpose output
- Power-Fail Time-Stamp:
 - Time logged on switchover to and from Battery mode

Low-Power Features:

- Wide Voltage Range:
 - Operating voltage range of 1.8V to 5.5V
 - Backup voltage range of 1.3V to 5.5V
- Low Typical Timekeeping Current:
 - Operating from Vcc: 1.2 µA at 3.3V
 - Operating from VBAT: 925 nA at 3.0V
- · Automatic Switchover to Battery Backup

User Memory:

- 64-byte Battery-Backed SRAM
- 1 Kbit EEPROM Memory:
 - Software write-protect
 - Page write up to 8 bytes
 - Endurance: 1M Erase/Write cycles
- 64-bit Protected EEPROM Area:
 - Robust write unlock sequence
 - EUI-48[™] MAC address (MCP79411)
 - EUI-64[™] MAC address (MCP79412)

Operating Ranges:

- 2-Wire Serial Interface, I²C[™] Compatible
 - I²C clock rate up to 400 kHz
- Temperature Range:
 - Industrial (I): -40°C to +85°C

Packages:

• 8-Lead SOIC, MSOP, TSSOP and 2x3 TDFN

General Description:

The MCP7941X Real-Time Clock/Calendar (RTCC) tracks time using internal counters for hours, minutes, seconds, days, months, years, and day of week. Alarms can be configured on all counters up to and including months. For usage and configuration, the MCP7941X supports I^2C communications up to 400 kHz.

The open-drain, multi-functional output can be configured to assert on an alarm match, to output a selectable frequency square wave, or as a general purpose output.

The MCP7941X is designed to operate using a 32.768 kHz tuning fork crystal with external crystal load capacitors. On-chip digital trimming can be used to adjust for frequency variance caused by crystal tolerance and temperature.

SRAM and timekeeping circuitry are powered from the backup supply when main power is lost, allowing the device to maintain accurate time and the SRAM contents. The times when the device switches over to the back-up supply and when primary power returns are both logged by the power-fail time-stamp.

The MCP7941X features 1 Kbit of internal nonvolatile EEPROM with software write-protectable regions. There is an additional 64 bits of protected nonvolatile memory which is only writable after an unlock sequence, making it ideal for storing a unique ID or other critical information. The MCP79411 and MCP79412 are pre-programmed with EUI-48 and EUI-64 addresses, respectively. Custom programming is also available.

Package Types

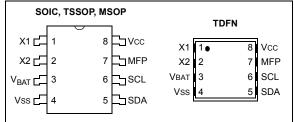
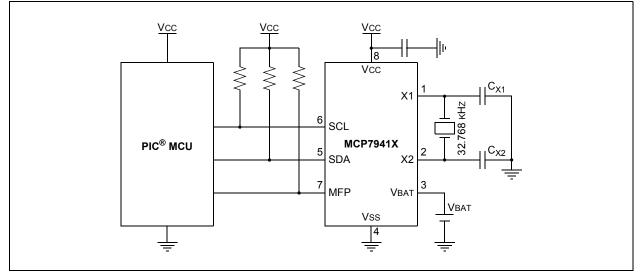
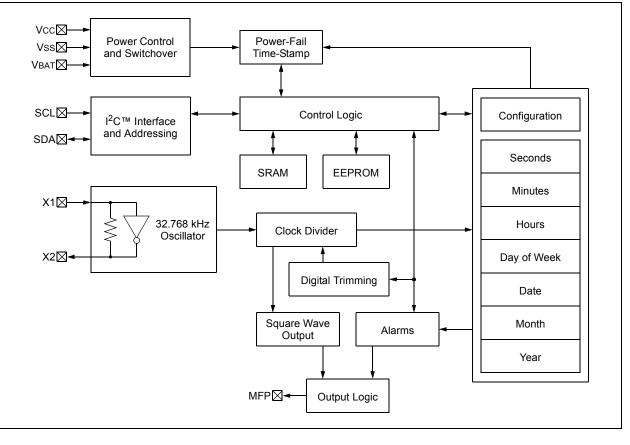


FIGURE 1-1: TYPICAL APPLICATION SCHEMATIC







1.0 ELECTRICAL CHARACTERISTICS

Absolute Maximum Ratings (†)

Vcc	6.5V
All inputs and outputs (except SDA and SCL) w.r.t. Vss	-0.6V to Vcc +1.0V
SDA and SCL w.r.t. Vss	-0.6V to 6.5V
Storage temperature	65°C to +150°C
Ambient temperature with power applied	40°C to +125°C
ESD protection on all pins	≥ 4 kV

† NOTICE: Stresses above those listed under "Absolute Maximum Ratings" may cause permanent damage to the device. This is a stress rating only and functional operation of the device at those or any other conditions above those indicated in the operational listings of this specification is not implied. Exposure to maximum rating conditions for extended periods may affect device reliability.

DC CHARACTERISTICS			Electrica Industrial		teristics: Vcc = +1		5V TA = -40°C to +85°C
Param. No.	Sym Characteristic		Min.	Тур. ⁽²⁾	Max.	Units	Conditions
D1	VIH	High-level input voltage	0.7 Vcc		_	V	—
D2	VIL	Low-level input voltage	—	—	0.3 Vcc 0.2 Vcc	V V	Vcc ≥ 2.5V Vcc < 2.5V
D3	VHYS	Hysteresis of Schmitt Trigger inputs (SDA, SCL pins)	0.05 Vcc	—	—	V	(Note 1)
D4	Vol	Low-level output voltage (MFP, SDA pins)	—	—	0.40	V	IOL = 3.0 mA @ VCC = 4.5V IOL = 2.1 mA @ VCC = 2.5V
D5	lu -	Input leakage current	—		±1	μA	VIN = VSS or VCC
D6	Ilo	Output leakage current	_		±1	μA	VOUT = VSS or VCC
D7	Cin, Cout	Pin capacitance (SDA, SCL, MFP pins)	—	—	10	pF	Vcc = 5.0V (Note 1) TA = 25°C, f = 1 MHz
D8	Cosc	Oscillator pin capacitance (X1, X2 pins)	—	3	—	pF	(Note 1)
D9	ICCEERD	EEPROM operating	_		400	μA	Vcc = 5.5V, SCL = 400 kHz
	ICCEEWR	current		_	3	mA	Vcc = 5.5V
D10	ICCREAD	SRAM/RTCC register	—	—	300	μA	Vcc = 5.5V, SCL = 400 kHz
	ICCWRITE	operating current	—	—	400	μA	Vcc = 5.5V, SCL = 400 kHz
D11	ICCDAT	Vcc data-retention current (oscillator off)	—	_	1	μΑ	SCL, SDA, Vcc = 5.5V
D12	Ісст	Timekeeping current	_	1.2	_	μA	Vcc = 3.3V (Note 1)
D13	Vtrip	Power-fail switchover voltage	1.3	1.5	1.7	V	—
D14	VBAT	Backup supply voltage range	1.3	—	5.5	V	(Note 1)
D15	IBATT	Timekeeping backup current	—	 925	850 1200 9000	nA nA nA	VBAT = 1.3V, VCC = VSS (Note 1) VBAT = 3.0V, VCC = VSS (Note 1) VBAT = 5.5V, VCC = VSS (Note 1)

TABLE 1-1: DC CHARACTERISTICS

Note 1: This parameter is not tested but ensured by characterization.

2: Typical measurements taken at room temperature.

DC CHARACTERISTICS (Continued)			Electrical Characteristics: Industrial (I): Vcc = +1.8V to 5.5V TA = -40°C to +85°C				
Param. No.	Sym.	Characteristic	Min.	Тур. ⁽²⁾	²⁾ Max. Units Conditio		Conditions
D16	IBATDAT	VBAT data retention current (oscillator off)	—	—	750	nA	VBAT = 3.6V, VCC = VSS

Note 1: This parameter is not tested but ensured by characterization.

2: Typical measurements taken at room temperature.

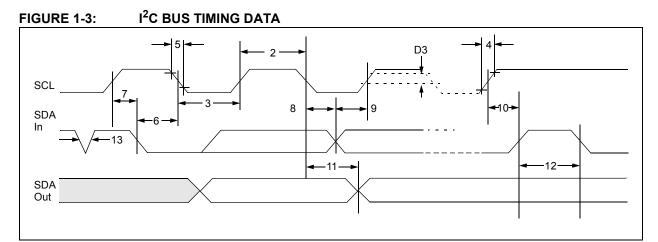
AC CHA	ARACTER	ISTICS	Electrical Characteristics: Industrial (I): Vcc = +1.8V to 5.5V			o 5.5V	TA = -40°C to +85°C		
Param. No.	Symbol	Characteristic	Min.	Тур.	Max.	Units	Conditions		
1	FCLK	Clock frequency	—	—	100 400	kHz	$\begin{array}{l} 1.8V \leq VCC < 2.5V \\ 2.5V \leq VCC \leq 5.5V \end{array}$		
2	Тнідн	Clock high time	4000 600			ns	$\begin{array}{l} 1.8 V \leq V \text{CC} < 2.5 V \\ 2.5 V \leq V \text{CC} \leq 5.5 V \end{array}$		
3	TLOW	Clock low time	4700 1300		_	ns	$\begin{array}{l} 1.8 V \leq V cc < 2.5 V \\ 2.5 V \leq V cc \leq 5.5 V \end{array}$		
4	Tr	SDA and SCL rise time (Note 1)			1000 300	ns	$\begin{array}{l} 1.8 V \leq V cc < 2.5 V \\ 2.5 V \leq V cc \leq 5.5 V \end{array}$		
5	TF	SDA and SCL fall time (Note 1)	—	—	1000 300	ns	$\begin{array}{l} 1.8V \leq Vcc < 2.5V \\ 2.5V \leq Vcc \leq 5.5V \end{array}$		
6	THD:STA	Start condition hold time	4000 600			ns	$\begin{array}{l} 1.8V \leq Vcc < 2.5V \\ 2.5V \leq Vcc \leq 5.5V \end{array}$		
7	TSU:STA	Start condition setup time	4700 600	_	_	ns	$\begin{array}{l} 1.8 V \leq V \text{CC} < 2.5 V \\ 2.5 V \leq V \text{CC} \leq 5.5 V \end{array}$		
8	THD:DAT	Data input hold time	0	—	—	ns	(Note 3)		
9	TSU:DAT	Data input setup time	250 100	_	_	ns	$\begin{array}{l} 1.8 \text{V} \leq \text{Vcc} < 2.5 \text{V} \\ 2.5 \text{V} \leq \text{Vcc} \leq 5.5 \text{V} \end{array}$		
10	TSU:STO	Stop condition setup time	4000 600	_	_	ns	$\begin{array}{l} 1.8 \text{V} \leq \text{Vcc} < 2.5 \text{V} \\ 2.5 \text{V} \leq \text{Vcc} \leq 5.5 \text{V} \end{array}$		
11	ΤΑΑ	Output valid from clock	_	_	3500 900	ns	$\begin{array}{l} 1.8 \text{V} \leq \text{Vcc} < 2.5 \text{V} \\ 2.5 \text{V} \leq \text{Vcc} \leq 5.5 \text{V} \end{array}$		
12	TBUF	Bus free time: Time the bus must be free before a new transmission can start	4700 1300	_	_	ns	1.8V ≤ Vcc < 2.5V 2.5V ≤ Vcc ≤ 5.5V		
13	TSP	Input filter spike suppression (SDA and SCL pins)	—	—	50	ns	(Note 1)		
14	Twc	Write cycle time (byte or page)		—	5	ms	—		
15	TFVCC	Vcc fall time	300		_	μs	(Note 1)		
16	TRVCC	Vcc rise time	0	—	_	μS	(Note 1)		
17	Fosc	Oscillator frequency	_	32.768		kHz	—		
18	TOSF	Oscillator timeout period	1	_		ms	(Note 1)		
19	—	Endurance	1M	—	_	cycles	Page Mode, 25°C, Vcc = 5.5V (Note 2)		

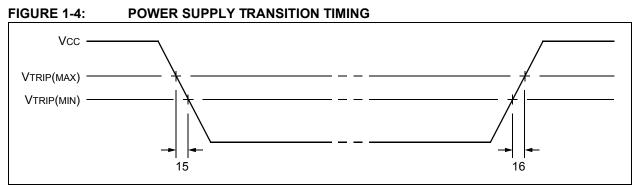
TABLE 1-2: AC CHARACTERISTICS

Note 1: Not 100% tested.

2: This parameter is not tested but ensured by characterization.

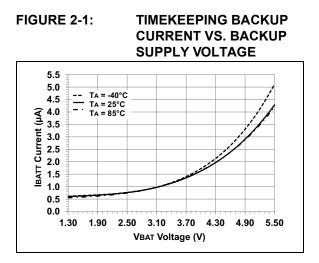
3: As a transmitter, the device must provide an internal minimum delay time to bridge the undefined region (minimum 300 ns) of the falling edge of SCL to avoid unintended generation of Start or Stop conditions.





2.0 TYPICAL PERFORMANCE CURVE

Note: The graphs and tables provided following this note are a statistical summary based on a limited number of samples and are provided for informational purposes only. The performance characteristics listed herein are not tested or guaranteed. In some graphs or tables, the data represented may be outside the specified operating range (e.g., outside specified power supply range) and therefore, outside the warranted range.



3.0 PIN DESCRIPTIONS

The descriptions of the pins are listed in Table 3-1.

Name	8-pin SOIC	8-pin MSOP	8-pin TSSOP	8-pin TDFN	Function				
X1	1	1	1	1	Quartz Crystal Input, External Oscillator Input				
X2	2	2	2	2	Quartz Crystal Output				
VBAT	3	3	3	3	Battery Backup Supply Input				
Vss	4	4	4	4	Ground				
SDA	5	5	5	5	Bidirectional Serial Data (I ² C™)				
SCL	6	6	6	6	Serial Clock (I ² C)				
MFP	7	7	7	7	Multifunction Pin				
Vcc	8	8	8	8	Primary Power Supply				

TABLE 3-1: PIN FUNCTION TABLE

Note: Exposed pad on TFDN can be connected to Vss or left floating.

3.1 Serial Data (SDA)

This is a bidirectional pin used to transfer addresses and data into and out of the device. It is an open-drain terminal. Therefore, the SDA bus requires a pull-up resistor to Vcc (typically 10 k Ω for 100 kHz, 2 k Ω for 400 kHz). For normal data transfer, SDA is allowed to change only during SCL low. Changes during SCL high are reserved for indicating the Start and Stop conditions.

3.2 Serial Clock (SCL)

This input is used to synchronize the data transfer to and from the device.

3.3 Oscillator Input/Output (X1, X2)

These pins are used as the connections for an external 32.768 kHz quartz crystal and load capacitors. X1 is the crystal oscillator input and X2 is the output. The MCP7941X is designed to allow for the use of external load capacitors in order to provide additional flexibility when choosing external crystals. The MCP7941X is optimized for crystals with a specified load capacitance of 6-9 pF.

X1 also serves as the external clock input when the MCP7941X is configured to use an external oscillator.

3.4 Multifunction Pin (MFP)

This is an output pin used for the alarm and square wave output functions. It can also serve as a general purpose output pin by controlling the OUT bit in the CONTROL register.

The MFP is an open-drain output and requires a pull-up resistor to Vcc (typically 10 k Ω). This pin may be left floating if not used.

3.5 Backup Supply (VBAT)

This is the input for a backup supply to maintain the RTCC and SRAM registers during the time when Vcc is unavailable.

If the battery backup feature is not being used, the VBAT pin should be connected to Vss.

4.0 I²C BUS CHARACTERISTICS

4.1 I²C Interface

The MCP7941X supports a bidirectional 2-wire bus and data transmission protocol. A device that sends data onto the bus is defined as transmitter, and a device receiving data as receiver. The bus has to be controlled by a master device which generates the Start and Stop conditions, while the MCP7941X works as slave. Both master and slave can operate as transmitter or receiver but the master device determines which mode is activated.

4.1.1 BUS CHARACTERISTICS

The following **bus protocol** has been defined:

- Data transfer may be initiated only when the bus is not busy.
- During data transfer, the data line must remain stable whenever the clock line is high. Changes in the data line while the clock line is high will be interpreted as a Start or Stop condition.

Accordingly, the following bus conditions have been defined (Figure 4-1).

4.1.1.1 Bus Not Busy (A)

Both data and clock lines remain high.

4.1.1.2 Start Data Transfer (B)

A high-to-low transition of the SDA line while the clock (SCL) is high determines a Start condition. All commands must be preceded by a Start condition.

4.1.1.3 Stop Data Transfer (C)

A low-to-high transition of the SDA line while the clock (SCL) is high determines a Stop condition. All operations must end with a Stop condition.

4.1.1.4 Data Valid (D)

The state of the data line represents valid data when, after a Start condition, the data line is stable for the duration of the high period of the clock signal.

The data on the line must be changed during the low period of the clock signal. There is one bit of data per clock pulse.

Each data transfer is initiated with a Start condition and terminated with a Stop condition. The number of the data bytes transferred between the Start and Stop conditions is determined by the master device.

4.1.1.5 Acknowledge

Each receiving device, when addressed, is obliged to generate an Acknowledge signal after the reception of each byte. The master device must generate an extra clock pulse which is associated with this Acknowledge bit.

- Note 1: The MCP7941X does not generate an Acknowledge in response to an EEPROM control byte if an internal EEPROM programming cycle is in progress, but the SRAM and RTCC registers can still be accessed.
 - **2:** The I²C interface is disabled while operating from the backup power supply.

A device that acknowledges must pull down the SDA line during the Acknowledge clock pulse in such a way that the SDA line is stable-low during the high period of the Acknowledge-related clock pulse. Of course, setup and hold times must be taken into account. During reads, a master must signal an end of data to the slave by NOT generating an Acknowledge bit on the last byte that has been clocked out of the slave. In this case, the slave (MCP7941X) will leave the data line high to enable the master to generate the Stop condition.

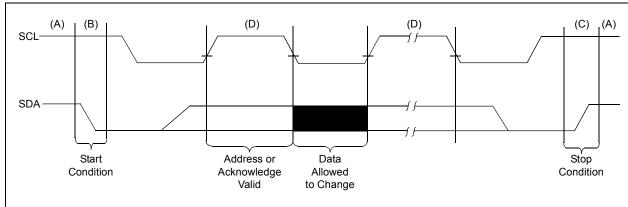
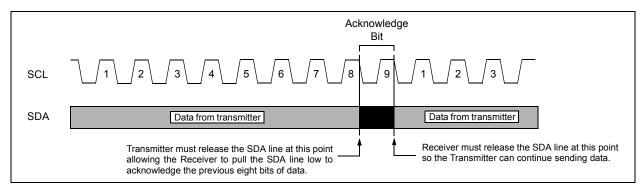


FIGURE 4-1: DATA TRANSFER SEQUENCE ON THE SERIAL BUS





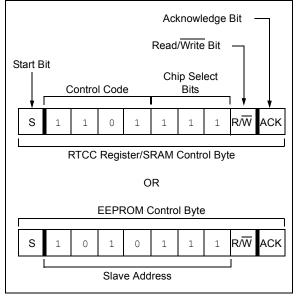
4.1.2 DEVICE ADDRESSING

The control byte is the first byte received following the Start condition from the master device (Figure 4-3). The control byte begins with a 4-bit control code. For the MCP7941X, this is set as '1010' for EEPROM read and write operations, and '1101' for SRAM/RTCC register read and write operations. The next three bits are non-configurable Chip Select bits that must always be set to '1'.

The last bit of the control byte defines the operation to be performed. When set to a '1' a read operation is selected, and when set to a '0' a write operation is selected.

The combination of the 4-bit control code and the three Chip Select bits is called the slave address. Upon receiving a valid slave address, the slave device outputs an acknowledge signal on the SDA line. Depending on the state of the R/W bit, the MCP7941X will select a read or a write operation.

FIGURE 4-3: CONTROL BYTE FORMAT



5.0 FUNCTIONAL DESCRIPTION

The MCP7941X is a highly-integrated Real-Time Clock/Calendar (RTCC). Using an on-board, lowpower oscillator, the current time is maintained in seconds, minutes, hours, day of week, date, month, and year. The MCP7941X also features 64 bytes of general purpose SRAM, 1 Kbit of EEPROM and eight bytes of protected EEPROM. Two alarm modules allow interrupts to be generated at specific times with flexible comparison options. Digital trimming can be used to compensate for inaccuracies inherent with crystals. Using the backup supply input and an integrated power switch, the MCP7941X will automatically switch to backup power when primary power is unavailable, allowing the current time and the SRAM contents to be maintained. The time-stamp module captures the time when primary power is lost and when it is restored.

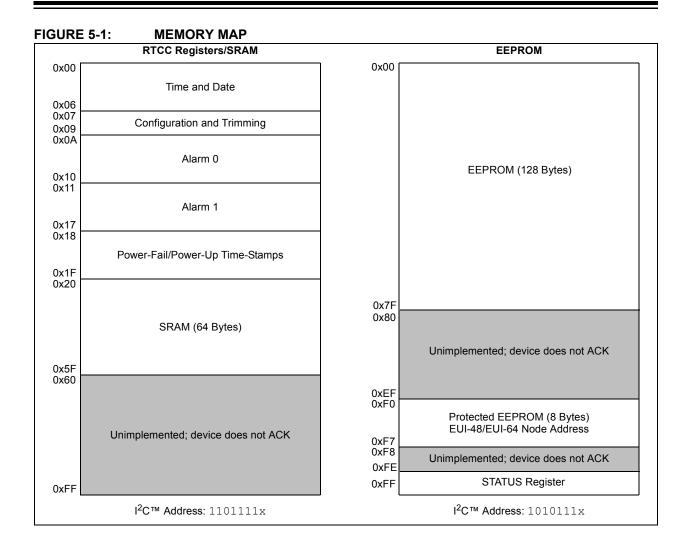
The RTCC configuration and STATUS registers are used to access all of the modules featured on the MCP7941X.

5.1 Memory Organization

The MCP7941X features four different blocks of memory: the RTCC registers, general purpose SRAM, 1 Kbit EEPROM with software write-protect, and protected EEPROM. The RTCC registers and SRAM share the same address space, accessed through the '11011111X' control byte. The EEPROM regions are in a separate address space and are accessed using the '10101111X' control byte (Figure 5-1). Unused locations are not accessible. The MCP7941X will not acknowledge if the address is out of range, as shown in the shaded region of the memory map in Figure 5-1.

The RTCC registers are contained in addresses 0x00-0x1F. Table 5-1 shows the detailed RTCC register map. There are 64 bytes of user-accessible SRAM, located in the address range 0x20-0x5F. The SRAM is a separate block from the RTCC registers. All RTCC registers and SRAM locations are maintained while operating from backup power.

The EEPROM space is located in addresses 0x00-0x7F while the protected EEPROM section is located in addresses 0xF0-0xF7. A STATUS register, used to protect regions of the EEPROM section, is located at address 0xFF.



Addr.	Register Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0
	-		5	Section 5.3 "	Timekeeping	"			
00h	RTCSEC	ST	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
01h	RTCMIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
02h	RTCHOUR	—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
03h	RTCWKDAY	—	—	OSCRUN	PWRFAIL	VBATEN	WKDAY2	WKDAY1	WKDAY0
04h	RTCDATE	—	_	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
05h	RTCMTH	—	_	LPYR	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
06h	RTCYEAR	YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0
07h	CONTROL	OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0
08h	OSCTRIM	SIGN	TRIMVAL6	TRIMVAL5	TRIMVAL4	TRIMVAL3	TRIMVAL2	TRIMVAL1	TRIMVAL0
09h	EEUNLOCK	Protected EE	PROM Unlock	Register (not	a physical reg	jister)			
				Section 5.4	4 "Alarms"				
0Ah	ALM0SEC	_	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
0Bh	ALMOMIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
0Ch	ALM0HOUR	_	12/24 ⁽²⁾	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
0Dh	ALM0WKDAY	ALMPOL	ALM0MSK2	ALM0MSK1	ALM0MSK0	ALM0IF	WKDAY2	WKDAY1	WKDAY0
0Eh	ALM0DATE	—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
0Fh	ALMOMTH	—	—	—	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
10h	Reserved	Reserved – D	Do not use		•	•	•	•	
				Section 5.4	4 "Alarms"				
11h	ALM1SEC	—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
12h	ALM1MIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
13h	ALM1HOUR	—	12/24 ⁽²⁾	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
14h	ALM1WKDAY	ALMPOL ⁽³⁾	ALM1MSK2	ALM1MSK1	ALM1MSK0	ALM1IF	WKDAY2	WKDAY1	WKDAY0
15h	ALM1DATE	_	_	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
16h	ALM1MTH	—	_	_	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
17h	Reserved	Reserved – I	Do not use						•
			Section	n 5.7.1 "Pow	er-Fail Time-	Stamp"			
				Power-Down	Time Stamp)			
18h	PWRDNMIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
19h	PWRDNHOUR	—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
1Ah	PWRDNDATE	—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
1Bh	PWRDNMTH	WKDAY2	WKDAY1	WKDAY0	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
				Power-Up	Fime Stamp				
1Ch	PWRUPMIN	_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
1Dh	PWRUPHOUR	—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
1Eh	PWRUPDATE	_	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
1Fh	PWRUPMTH	WKDAY2	WKDAY1	WKDAY0	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
Note	1: Grey areas	are unimple	mented		•	•	•	•	•

TABLE 5-1: DETAILED RTCC REGISTER MAP

Note 1: Grey areas are unimplemented.

2: The 12/24 bits in the ALMxHOUR registers are read-only and reflect the value of the 12/24 bit in the RTCHOUR register.

3: The ALMPOL bit in the ALM1WKDAY register is read-only and reflects the value of the ALMPOL bit in the ALM0WKDAY register.

5.2 Oscillator Configuration

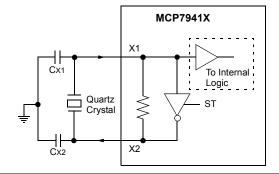
The MCP7941X can be operated in two different oscillator configurations: using an external crystal or using an external clock input.

5.2.1 EXTERNAL CRYSTAL

The crystal oscillator circuit on the MCP7941X is designed to operate with a standard 32.768 kHz tuning fork crystal and matching external load capacitors. By using external load capacitors, the MCP7941X allows for a wide selection of crystals. Suitable crystals have a load capacitance (CL) of 6-9 pF. Crystals with a load capacitance of 12.5 pF are not recommended.

Figure 5-2 shows the pin connections when using an external crystal.





- Note 1: The ST bit must be set to enable the crystal oscillator circuit.
 - 2: Always verify oscillator performance over the voltage and temperature range that is expected for the application.

5.2.1.1 Choosing Load Capacitors

CL is the effective load capacitance as seen by the crystal, and includes the physical load capacitors, pin capacitance, and stray board capacitance. Equation 5-1 can be used to calculate CL.

 C_{X1} and C_{X2} are the external load capacitors. They must be chosen to match the selected crystal's specified load capacitance.

Note: If the load capacitance is not correctly matched to the chosen crystal's specified value, the crystal may give a frequency outside of the crystal manufacturer's specifications.

EQUATION 5-1: LOAD CAPACITANCE CALCULATION

$$CL = \frac{C_{X1} \times C_{X2}}{C_{X1} + C_{X2}} + CSTRAY$$

Where:

CL = Effective load capacitance C_{X1} = Capacitor value on X1 + Cosc C_{X2} = Capacitor value on X2 + Cosc CSTRAY = PCB stray capacitance

5.2.1.2 Layout Considerations

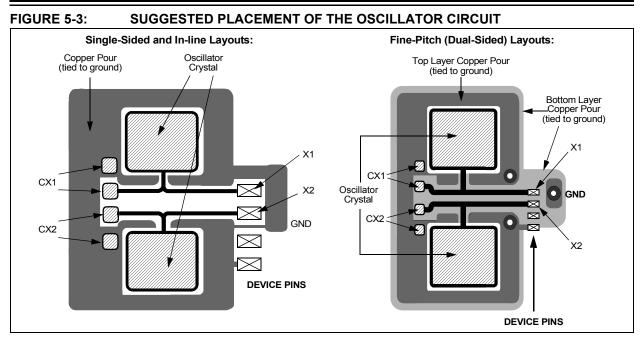
The oscillator circuit should be placed on the same side of the board as the device. Place the oscillator circuit close to the respective oscillator pins. The load capacitors should be placed next to the oscillator itself, on the same side of the board.

Use a grounded copper pour around the oscillator circuit to isolate it from surrounding circuits. The grounded copper pour should be routed directly to Vss. Do not run any signal traces or power traces inside the ground pour. Also, if using a two-sided board, avoid any traces on the other side of the board where the crystal is placed.

Layout suggestions are shown in Figure 5-3. In-line packages may be handled with a single-sided layout that completely encompasses the oscillator pins. With fine-pitch packages, it is not always possible to completely surround the pins and components. A suitable solution is to tie the broken guard sections to a mirrored ground layer. In all cases, the guard trace(s) must be returned to ground.

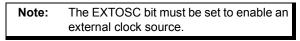
For additional information and design guidance on oscillator circuits, please refer to these Microchip Application Notes, available at the corporate web site (www.microchip.com):

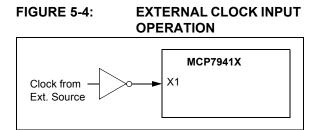
- AN1365, "Recommended Usage of Microchip Serial RTCC Devices"
- AN1519, "Recommended Crystals for Microchip Stand-Alone Real-Time Clock Calendar Devices"



5.2.2 EXTERNAL CLOCK INPUT

A 32.768 kHz external clock source can be connected to the X1 pin (Figure 5-4). When using this configuration, the X2 pin should be left floating.





5.2.3 OSCILLATOR FAILURE STATUS

The MCP7941X features an oscillator failure flag, OSCRUN, that indicates whether or not the oscillator is running. The OSCRUN bit is automatically set after 32 oscillator cycles are detected. If no oscillator cycles are detected for more than ToSF, then the OSCRUN bit is automatically cleared (Figure 5-5). This can occur if the oscillator is stopped by clearing the ST bit or due to oscillator failure.



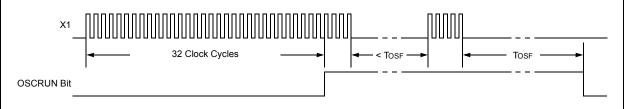


TABLE 5-2: SUMMARY OF REGISTERS ASSOCIATED WITH OSCILLATOR CONFIGURATION

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
RTCSEC	ST	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0	17
RTCWKDAY	_	_	OSCRUN	PWRFAIL	VBATEN	WKDAY2	WKDAY1	WKDAY0	19
CONTROL	OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0	27

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by oscillator configuration.

5.3 Timekeeping

The MCP7941X maintains the current time and date using an external 32.768 kHz crystal or clock source. Separate registers are used for tracking seconds, minutes, hours, day of week, date, month, and year. The MCP7941X automatically adjusts for months with less than 31 days and compensates for leap years from 2001 to 2399. The year is stored as a two-digit value.

Both 12-hour and 24-hour time formats are supported and are selected using the 12/24 bit.

The day of week value counts from 1 to 7, increments at midnight, and the representation is user-defined (i.e., the MCP7941X does not require 1 to equal Sunday, etc.).

All time and date values are stored in the registers as binary-coded decimal (BCD) values. The MCP7941X will continue to maintain the time and date while operating off the backup supply.

When reading from the timekeeping registers, the registers are buffered to prevent errors due to rollover of counters. The following events cause the buffers to be updated:

- When a read is initiated from the RTCC registers (addresses 0x00 to 0x1F)
- During an RTCC register read operation, when the register address rolls over from 0x1F to 0x00

The timekeeping registers should be read in a single operation to utilize the on-board buffers and avoid rollover issues.

Note 1:	Loading invalid values into the time and date registers will result in undefined operation.
2:	To avoid rollover issues when loading new time and date values, the oscillator/

new time and date values, the oscillator/ clock input should be disabled by clearing the ST bit for External Crystal mode and the EXTOSC bit for External Clock Input mode. After waiting for the OSCRUN bit to clear, the new values can be loaded and the ST or EXTOSC bit can then be re-enabled.

5.3.1 DIGIT CARRY RULES

The following list explains which timer values cause a digit carry when there is a rollover:

- Time of day: from 11:59:59 PM to 12:00:00 AM (12-hour mode) or 23:59:59 to 00:00:00 (24-hour mode), with a carry to the Date and Weekday fields
- Date: carries to the Month field according to Table 5-3
- · Weekday: from 7 to 1 with no carry
- Month: from 12/31 to 01/01 with a carry to the Year field
- · Year: from 99 to 00 with no carry

TABLE 5-3:	DAY TO MONTH ROLLOVER
	SCHEDULE

Month	Name	Maximum Date
01	January	31
02	February	28 or 29 ⁽¹⁾
03	March	31
04	April	30
05	May	31
06	June	30
07	July	31
08	August	31
09	September	30
10	October	31
11	November	30
12	December	31

Note 1: 29 during leap years, otherwise 28.

REGISTER 5-1: RTCSEC: TIMEKEEPING SECONDS VALUE REGISTER (ADDRESS 0x00)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
ST	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 7	ST: Start Oscillator bit
	1 = Oscillator enabled0 = Oscillator disabled
bit 6-4	SECTEN<2:0>: Binary-Coded Decimal Value of Second's Tens Digit Contains a value from 0 to 5
bit 3-0	SECONE<3:0>: Binary-Coded Decimal Value of Second's Ones Digit Contains a value from 0 to 9

REGISTER 5-2: RTCMIN: TIMEKEEPING MINUTES VALUE REGISTER (ADDRESS 0x01)

U-0	R/W-0						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented b	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 7	Unimplemented: Read as '0

bit 6-4	MINTEN<2:0>: Binary-Coded Decimal Value of Minute's Tens Digit
	Contains a value from 0 to 5
bit 3-0	MINONE<3:0>: Binary-Coded Decimal Value of Minute's Ones Digit
	Contains a value from 0 to 9

REGISTER 5-3: RTCHOUR: TIMEKEEPING HOURS VALUE REGISTER (ADDRESS 0x02)

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
_	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

If 12/24 = 1 (12-hour format):

11 12/24 = 1(12)	<u>L'illuir loimaig.</u>
bit 7	Unimplemented: Read as '0'
bit 6	12/24: 12 or 24 Hour Time Format bit
	1 = 12-hour format
	0 = 24-hour format
bit 5	AM/PM: AM/PM Indicator bit
	1 = PM
	0 = AM
bit 4	HRTEN0: Binary-Coded Decimal Value of Hour's Tens Digit
	Contains a value from 0 to 1
bit 3-0	HRONE<3:0>: Binary-Coded Decimal Value of Hour's Ones Digit
	Contains a value from 0 to 9
<u>If 12/24 = 0 (24</u>	4-hour format):
bit 7	Unimplemented: Read as '0'
bit 6	12/24: 12 or 24 Hour Time Format bit
	1 = 12-hour format
	0 = 24-hour format
bit 5-4	HRTEN<1:0>: Binary-Coded Decimal Value of Hour's Tens Digit
	Contains a value from 0 to 2.
bit 3-0	HRONE<3:0>: Binary-Coded Decimal Value of Hour's Ones Digit
	Contains a value from 0 to 9

REGISTER 5-4: RTCWKDAY: TIMEKEEPING WEEKDAY VALUE REGISTER (ADDRESS 0x03)

U-0	U-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
—	—	OSCRUN	PWRFAIL	VBATEN	WKDAY2	WKDAY1	WKDAY0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	d as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 7-6	Unimplemented: Read as '0'
bit 5	OSCRUN: Oscillator Status bit
	1 = Oscillator is enabled and running
	0 = Oscillator has stopped or has been disabled
bit 4	PWRFAIL : Power Failure Status bit ^(1,2)
	 1 = Primary power was lost and the power-fail time-stamp registers have been loaded (must be cleared in software). Clearing this bit resets the power-fail time-stamp registers to '0'. 0 = Primary power has not been lost
bit 3	VBATEN: External Battery Backup Supply (VBAT) Enable bit
	1 = VBAT input is enabled
	0 = VBAT input is disabled
bit 2-0	WKDAY<2:0>: Binary-Coded Decimal Value of Day of Week
	Contains a value from 1 to 7. The representation is user-defined.
Note 1:	The PWRFAIL bit must be cleared to log new time-stamp data. This is to ensure previous time-stamp data is not lost.

2: The PWRFAIL bit cannot be written to a '1' in software. Writing to the RTCWKDAY register will always clear the PWRFAIL bit.

REGISTER 5-5: RTCDATE: TIMEKEEPING DATE VALUE REGISTER (ADDRESS 0x04)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
_	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented b	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown		

bit 7-6	Unimplemented: Read as '0'
bit 5-4	DATETEN<1:0>: Binary-Coded Decimal Value of Date's Tens Digit
	Contains a value from 0 to 3
bit 3-0	DATEONE<3:0>: Binary-Coded Decimal Value of Date's Ones Digit
	Contains a value from 0 to 9

REGISTER 5-6: RTCMTH: TIMEKEEPING MONTH VALUE REGISTER (ADDRESS 0x05)

U-0	U-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1		
—	—	LPYR	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0		
bit 7			·				bit 0		
Legend:									
R = Readable	e bit	W = Writable	bit	U = Unimpler	nented bit, read	as '0'			
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clear x = Bit is unknown			nown		
bit 7-6	Unimplemen	ted: Read as '	0'						
bit 5	LPYR: Leap	rear bit							
	1 = Year is a l	eap year							
	0 = Year is no	0 = Year is not a leap year							
bit 4	MTHTEN0: Binary-Coded Decimal Value of Month's Tens Digit								
	Contains a va	lue of 0 or 1							
bit 3-0	MTHONE<3:0	MTHONE<3:0>: Binary-Coded Decimal Value of Month's Ones Digit							

Contains a value from 0 to 9

REGISTER 5-7: RTCYEAR: TIMEKEEPING YEAR VALUE REGISTER (ADDRESS 0x06)

R/W-0	R/W-1						
YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 7-4	YRTEN<3:0>: Binary-Coded Decimal Value of Year's Tens Digit
	Contains a value from 0 to 9
bit 3-0	YRONE<3:0>: Binary-Coded Decimal Value of Year's Ones Digit

Contains a value from 0 to 9

TABLE 5-4: SUMMARY OF REGISTERS ASSOCIATED WITH TIMEKEEPING

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
RTCSEC	ST	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0	17
RTCMIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0	18
RTCHOUR	—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0	18
RTCWKDAY	—	_	OSCRUN	PWRFAIL	VBATEN	WKDAY2	WKDAY1	WKDAY0	19
RTCDATE	—	_	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0	19
RTCMTH	—		LPYR	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0	20
RTCYEAR	YRTEN3	YRTEN2	YRTEN1	YRTEN0	YRONE3	YRONE2	YRONE1	YRONE0	20

Legend: — = unimplemented location, read as '0'. Shaded cells are not used in timekeeping.

5.4 Alarms

The MCP7941X features two independent alarms. Each alarm can be used to either generate an interrupt at a specific time in the future, or to generate a periodic interrupt every minute, hour, day, day of week, or month.

There is a separate interrupt flag, ALMxIF, for each alarm. The interrupt flags are set by hardware when the chosen alarm mask condition matches (Table 5-5). The interrupt flags must be cleared in software.

If either alarm module is enabled by setting the corresponding ALMxEN bit in the CONTROL register, and if the square wave clock output is disabled (SQWEN = 0), then the MFP will operate in Alarm Interrupt Output mode. Refer to **Section 5.5 "Output Configurations"** for details. The alarm interrupt output is available while operating from the backup power supply.

Both Alarm0 and Alarm1 offer identical operation. All time and date values are stored in the registers as binary-coded decimal (BCD) values.

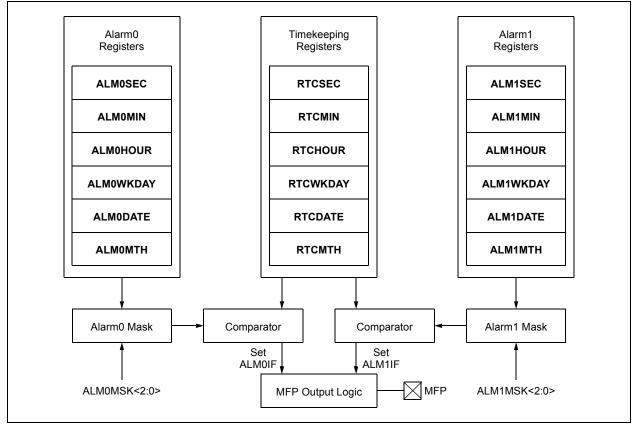
Note: Throughout this section, references to the register and bit names for the alarm modules are referred to generically by the use of 'x' in place of the specific module number. Thus, "ALMxSEC" might refer to the seconds register for Alarm0 or Alarm1.

FIGURE 5-6: ALARM BLOCK DIAGRAM

TABLE 5-5:ALARM MASKS

ALMxMSK<2:0>	Alarm Asserts on Match of
000	Seconds
001	Minutes
010	Hours
011	Day of Week
100	Date
101	Reserved
110	Reserved
111	Seconds, Minutes, Hours, Day of Week, Date, and Month

- Note 1: The alarm interrupt flags must be cleared by the user. If a flag is cleared while the corresponding alarm condition still matches, the flag will be set again, generating another interrupt.
 - **2:** Loading invalid values into the alarm registers will result in undefined operation.



© 2010-2014 Microchip Technology Inc.

5.4.1 CONFIGURING THE ALARM

In order to configure the alarm modules, the following steps need to be performed:

- 1. Load the timekeeping registers and enable the oscillator
- 2. Configure the ALMxMSK<2:0> bits to select the desired alarm mask
- 3. Set or clear the ALMPOL bit according to the desired output polarity
- 4. Ensure the ALMxIF flag is cleared
- Based on the selected alarm mask, load the alarm match value into the appropriate register(s)
- 6. Enable the alarm module by setting the ALMxEN bit

REGISTER 5-8: ALMxSEC: ALARM0/1 SECONDS VALUE REGISTER (ADDRESSES 0x0A/0x11)

U-0	R/W-0						
—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	W = Writable bit U = Unimplemented bit, read as '0'			
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown		

bit 7 Unimplemented: Read as '0'

- bit 6-4 SECTEN<2:0>: Binary-Coded Decimal Value of Second's Tens Digit Contains a value from 0 to 5
- bit 3-0 SECONE<3:0>: Binary-Coded Decimal Value of Second's Ones Digit Contains a value from 0 to 9

REGISTER 5-9: ALMxMIN: ALARM0/1 MINUTES VALUE REGISTER (ADDRESSES 0x0B/0x12)

U-0	R/W-0						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 7	Unimplemented: Read as '0'
bit 6-4	MINTEN<2:0>: Binary-Coded Decimal Value of Minute's Tens Digit
	Contains a value from 0 to 5
bit 3-0	MINONE<3:0>: Binary-Coded Decimal Value of Minute's Ones Digit
	Contains a value from 0 to 9

U-0	R-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit (
Legend:							
R = Reada	able bit	W = Writable	bit	U = Unimpler	mented bit, read	l as '0'	
-n = Value	e at POR	'1' = Bit is set		'0' = Bit is cle	ar	x = Bit is unkr	nown
If 12/24 =	1 (12-hour forma	at):					
bit 7		ented: Read as '	0'				
bit 6		r 24 Hour Time F					
		1 = 12-hour format 0 = 24-hour format					
bit 5	AM/PM: AN	//PM Indicator bi	t				
	1 = PM 0 = AM						
bit 4	HRTEN0: E	Binary-Coded De	cimal Value of	Hour's Tens D	Digit		
	Contains a	value from 0 to 1					
bit 3-0	HRONE<3:0>: Binary-Coded Decimal Value of Hour's Ones Digit						
	Contains a value from 0 to 9						
<u> If 12/24 =</u>	0 (24-hour forma	<u>at):</u>					
bit 7		Unimplemented: Read as '0'					
bit 6		12/24: 12 or 24 Hour Time Format bit ⁽¹⁾					
	1 = 12-hou						
	0 = 24-hou						
bit 5-4		0>: Binary-Code		ue of Hour's Te	ens Digit		
		value from 0 to 2		us of Llour's O	nee Disit		
bit 3-0	HRONE<3:	0>: Binary-Code	u Decimai Val	ue of Hour's O	ines Digit		
	Contains a	value from 0 to 9					

REGISTER 5-10: ALMxHOUR: ALARM0/1 HOURS VALUE REGISTER (ADDRESSES 0x0C/0x13)

REGISTER 5-11:	ALMxWKDAY: ALARM0/1 WEEKDAY VALUE REGISTER (ADDRESSES 0x0D/
	0x14)

R/W-0) R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
ALMPC	L ALMxMSK2	ALMxMSK1	ALMxMSK0	ALMxIF	WKDAY2	WKDAY1	WKDAY0
bit 7					•	•	bit 0
Legend:							
R = Read	able bit	W = Writable	bit	U = Unimple	mented bit, read	d as '0'	
-n = Value	at POR	'1' = Bit is set		'0' = Bit is cle	ar	x = Bit is unkr	nown
bit 7	ALMPOL: Ala	arm Interrupt O	utput Polarity b	bit			
		output state of	•	•			
	0 = Asserted	output state of	MFP is a logic	low level			
bit 6-4	ALMxMSK<2:0>: Alarm Mask bits						
	000 = Second						
		001 = Minutes match					
		match (logic ta	kes into accoui	nt 12-/24-hou	r operation)		
	011 = Day of 100 = Date m						
	101 = Reserved; do not use						
		ed; do not use					
	111 = Second	ds, Minutes, Ho	our, Day of Wee	ek, Date and	Month		
bit 3	ALMxIF: Alar	m Interrupt Fla	g bit ^(1,2)				
	1 = Alarm match occurred (must be cleared in software)						
	0 = Alarm ma	tch did not occ	ur				
bit 2-0	WKDAY<2:0>	Binary-Code	d Decimal Valu	ie of Day bits			
	Contains a va	alue from 1 to 7	. The represen	tation is user	-defined.		
Note 1:	If a match conditio	n still exists wh	en this bit is cl	eared, it will b	e set again aut	omatically.	

2: The ALMxIF bit cannot be written to a 1 in software. Writing to the ALMxWKDAY register will always clear the ALMxIF bit.

REGISTER 5-12: ALMxDATE: ALARM0/1 DATE VALUE REGISTER (ADDRESSES 0x0E/0x15)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	t, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 5-4	DATETEN<1:0>: Binary-Coded Decimal Value of Date's Tens Digit
	Contains a value from 0 to 3
bit 3-0	DATEONE<3:0>: Binary-Coded Decimal Value of Date's Ones Digit

Contains a value from 0 to 9

REGISTER 5-13: ALMxMTH: ALARM0/1 MONTH VALUE REGISTER (ADDRESSES 0x0F/0x16)

U-0	U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-1
—			MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bit, read	l as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown

bit 7-5	Unimplemented: Read as '0'
---------	----------------------------

bit 4	MTHTEN0: Binary-Coded Decimal Value of Month's Tens Digit
	Contains a value of 0 or 1
bit 3-0	MTHONE<3:0>: Binary-Coded Decimal Value of Month's Ones Digit
	Contains a value from 0 to 9

TABLE 5-6: SUMMARY OF REGISTERS ASSOCIATED WITH ALARMS

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ALM0SEC	—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0	22
ALM0MIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0	22
ALM0HOUR	—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0	23
ALM0WKDAY	ALMPOL	ALM0MSK2	ALM0MSK1	ALM0MSK0	ALM0IF	WKDAY2	WKDAY1	WKDAY0	24
ALM0DATE	—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0	24
ALM0MTH	—	—	_	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0	25
ALM1SEC	—	SECTEN2	SECTEN1	SECTEN0	SECONE3	SECONE2	SECONE1	SECONE0	22
ALM1MIN	—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0	22
ALM1HOUR	-	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0	23
ALM1WKDAY	ALMPOL	ALM1MSK2	ALM1MSK1	ALM1MSK0	ALM1IF	WKDAY2	WKDAY1	WKDAY0	24
ALM1DATE	_	_	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0	24
ALM1MTH	_	—	_	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0	25
CONTROL	OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0	27

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by alarms.

5.5 Output Configurations

The MCP7941X features Square Wave Clock Output, Alarm Interrupt Output, and General Purpose Output modes. All of the output functions are multiplexed onto MFP according to Table 5-7.

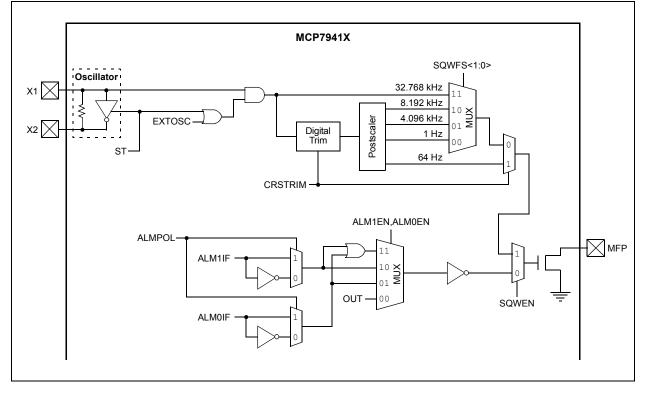
Only the alarm interrupt outputs are available while operating from the backup power supply. If none of the output functions are being used, the MFP can safely be left floating.

Note:	The MFP is an open-drain output and
	requires a pull-up resistor to VCC (typically
	10 kΩ).

TABLE 5-7: MFP OUTPUT MODES

SQWEN	ALM0EN	ALM1EN	Mode
0	0	0	General Purpose Output
0	1	0	
0	0	1	Alarm Interrupt Output
0	1	1	Output
1	х	х	Square Wave Clock Output

FIGURE 5-7: MFP OUTPUT BLOCK DIAGRAM



R/W-2	1 R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0
bit 7	bit 6	bit 5	bit 4	bit 3	bit 2	bit 1	bit 0
_egend:							
R = Read	able bit	W = Writable	bit	U = Unimpler	nented bit, read	as '0'	
n = Value		'1' = Bit is set		'0' = Bit is cle		x = Bit is unkr	own
							IOWIT
oit 7	OUT: Logic L	evel for Genera	al Purpose Ou	tput bit			
	•	e Clock Output	mode (SQWE	<u>N = 1):</u>			
	Unused.						
	<u>Alarm Interru</u> Unused.	pt Output mode	<u>e (ALM0EN = 1</u>	1 or ALM1EN =	<u>= 1):</u>		
				<u>= 0, ALM0EN =</u>	<u>0, and ALM1E</u>	<u>N = 0):</u>	
	Ų	al level is logic al level is logic	U U				
oit 6	SQWEN: Squ	uare Wave Out	out Enable bit				
		quare Wave Cl					
	0 = Disable S	quare Wave C	ock Output m	ode			
oit 5	ALM1EN: Ala	arm 1 Module E	nable bit				
	1 = Alarm 1 e 0 = Alarm 1 c						
oit 4	ALMOEN: Ala	arm 0 Module E	nable bit				
	1 = Alarm 0 e 0 = Alarm 0 c						
oit 3		ternal Oscillato	r Input bit				
	1 = Enable X	1 pin to be drive external 32.768	en by external	32.768 kHz so	ource		
oit 2		oarse Trim Mo					
				IX applying did	ital trimming ev	ery 64 Hz cloc	k cycle.
					output trimmed 6		
		Coarse Trim mo					
		5.6 "Digital Tr	-		. 1 1. 90.		
bit 1-0		>: Square Wav		t Frequency S	elect dits		
		<u>1</u> and CRSTRII ency of clock o					
	00 = 1 Hz ⁽¹⁾	-					
	01 = 4.096 kl						
	10 = 8.192 kl						
	11 = 32.768		- 1.				
	<u>If SQWEN =</u> Unused.	0 or CRSTRIM	<u>= 1:</u>				
Note 1:	The 8.192 kHz, 4.0	196 kHz 64 Hz	and 1 Hz cou	iare wave clos	k output freque	ncies are affec	ted by diaits
	111C 0.132 NIZ. 4.	000 NHZ. 04 NZ	, anu i nz syt		n output neque	10100 010 01100	ica by ululle

REGISTER 5-14: CONTROL: RTCC CONTROL REGISTER (ADDRESS 0x07)

5.5.1 SQUARE WAVE OUTPUT MODE

The MCP7941X can be configured to generate a square wave clock signal on MFP. The input clock frequency, Fosc, is divided according to the SQWFS<1:0> bits as shown in Table 5-8.

The square wave output is not available when operating from the backup power supply.

Note:	All of th	e clock out	put rates	are a	ffecte	d by				
	digital	digital trimming except for the 1:1								
	postsca	postscaler value (SQWFS<1:0> = 00).								

TABLE 5-8: CLOCK OUTPUT RATES

SQWFS<1:0>	Postscaler	Nominal Frequency
0.0	1:1	32.768 kHz
01	1:4	8.192 kHz
10	1:8	4.096 kHz
11	1:32,768	1 Hz

Note 1: Nominal frequency assumes Fosc is 32.768 kHz.

5.5.2 ALARM INTERRUPT OUTPUT MODE

The MFP will provide an interrupt output when enabled alarms match and the square wave clock output is disabled. This prevents the user from having to poll the alarm interrupt flag to check for a match.

The alarm interrupt output is available when operating from the backup power supply.

The ALMxIF flags control when the MFP is asserted, as described in the following sections.

5.5.2.1 Single Alarm Operation

When only one alarm module is enabled, the MFP output is based on the corresponding ALMxIF flag and the ALMPOL flag. If ALMPOL = 1, the MFP output reflects the value of the ALMxIF flag. If ALMPOL = 0, the MFP output reflects the inverse of the ALMxIF flag (Table 5-9).

TABLE 5-9:	SINGLE ALARM OUTPUT
	TRUTH TABLE

ALMPOL	ALMxIF ⁽¹⁾	MFP
0	0	1
0	1	0
1	0	0
1	1	1

Note 1: ALMxIF refers to the interrupt flag corresponding to the alarm module that is enabled.

5.5.2.2 Dual Alarm Operation

When both alarm modules are enabled, the MFP output is determined by a combination of the ALM0IF, ALM1IF, and ALMPOL flags.

If ALMPOL = 1, the ALMOIF and ALM1IF flags are OR'd together and the result is output on MFP. If ALMPOL = 0, the ALM0IF and ALM1IF flags are AND'd together, and the result is inverted and output on MFP (Table 5-10). This provides the user with flexible options for combining alarms.

Note: If ALMPOL = 0 and both alarms are enabled, the MFP will only assert when both ALM0IF and ALM1IF are set.

TABLE 5-10:	DUAL ALARM OUTPUT
	TRUTH TABLE

ALMPOL	ALM0IF	ALM1IF	MFP
0	0	0	1
0	0	1	1
0	1	0	1
0	1	1	0
1	0	0	0
1	0	1	1
1	1	0	1
1	1	1	1

5.5.3 GENERAL PURPOSE OUTPUT MODE

If the square wave clock output and both alarm modules are disabled, the MFP acts as a general purpose output. The output logic level is controlled by the OUT bit.

The general purpose output is not available when operating from the backup power supply.

Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
ALMPOL	ALM0MSK2	ALM0MSK1	ALM0MSK0	ALM0IF	WKDAY2	WKDAY1	WKDAY0	24
ALMPOL	ALM1MSK2	ALM1MSK1	ALM1MSK0	ALM1IF	WKDAY2	WKDAY1	WKDAY0	24
OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0	27
-	ALMPOL ALMPOL	ALMPOL ALM0MSK2 ALMPOL ALM1MSK2	ALMPOL ALM0MSK2 ALM0MSK1 ALMPOL ALM1MSK2 ALM1MSK1	ALMPOL ALM0MSK2 ALM0MSK1 ALM0MSK0 ALMPOL ALM1MSK2 ALM1MSK1 ALM1MSK0	ALMPOL ALM0MSK2 ALM0MSK1 ALM0MSK0 ALM0IF ALMPOL ALM1MSK2 ALM1MSK1 ALM1MSK0 ALM1IF	ALMPOL ALM0MSK2 ALM0MSK1 ALM0MSK0 ALM0IF WKDAY2 ALMPOL ALM1MSK2 ALM1MSK1 ALM1MSK0 ALM1IF WKDAY2	ALMPOL ALM0MSK2 ALM0MSK1 ALM0MSK0 ALM0IF WKDAY2 WKDAY1 ALMPOL ALM1MSK2 ALM1MSK1 ALM1MSK0 ALM1IF WKDAY2 WKDAY1	ALMPOL ALM0MSK2 ALM0MSK1 ALM0MSK0 ALM0IF WKDAY2 WKDAY1 WKDAY0 ALMPOL ALM1MSK2 ALM1MSK1 ALM1MSK0 ALM1IF WKDAY2 WKDAY1 WKDAY0

TABLE 5-11: SUMMARY OF REGISTERS ASSOCIATED WITH OUTPUT CONFIGURATION

Legend: — = unimplemented location, read as '0'. Shaded cells are not used in output configuration.

5.6 Digital Trimming

The MCP7941X features digital trimming to correct for inaccuracies of the external crystal or clock source, up to roughly ± 129 PPM when CRSTRIM = 0. In addition to compensating for intrinsic inaccuracies in the clock, this feature can also be used to correct for error due to temperature variation. This can enable the user to achieve high levels of accuracy across a wide temperature operating range.

Digital trimming consists of the MCP7941X periodically adding or subtracting clock cycles, resulting in small adjustments in the internal timing. The adjustment occurs once per minute when CRSTRIM = 0. The SIGN bit specifies whether to add cycles or to subtract them. The TRIMVAL<6:0> bits are used to specify by how many clock cycles to adjust. Each step in the TRIMVAL<6:0> value equates to adding or subtracting two clock pulses to or from the 32.768 kHz clock signal. This results in a correction of roughly 1.017 PPM per step when CRSTRIM = 0. Setting TRIMVAL<6:0> to 0x00 disables digital trimming.

Digital trimming also occurs while operating off the backup supply.

REGISTER 5-15: OSCTRIM: OSCILLATOR DIGITAL TRIM REGISTER (ADDRESS 0x08)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	
SIGN	TRIMVAL6	TRIMVAL5	TRIMVAL4	TRIMVAL3	TRIMVAL2	TRIMVAL1	TRIMVAL0	
bit 7							bit 0	
Legend:								
R = Readable bit		W = Writable bit		U = Unimplemented bit, read as '0'				
-n = Value at	POR	'1' = Bit is set		'0' = Bit is clear		x = Bit is unknown		
bit 7	SIGN: Trim S	ign bit						
	1 = Add clock	s to correct for	slow time					
	0 = Subtract of	clocks to correc	t for fast time					
bit 6-0	TRIMVAL<6:	0>: Oscillator T	rim Value bits					
2								

When CRSTRIM = 0:

- 1111111 = Add or subtract 254 clock cycles every minute
- 1111110 = Add or subtract 252 clock cycles every minute

•

0000010 = Add or subtract 4 clock cycles every minute

0000001 = Add or subtract 2 clock cycles every minute 0000000 = Disable digital trimming

When CRSTRIM = 1:

1111111 = Add or subtract 254 clock cycles 128 times per second 1111110 = Add or subtract 252 clock cycles 128 times per second

- 0000000 = Disable digital trimming

5.6.1 CALIBRATION

In order to perform calibration, the number of error clock pulses per minute must be found and the corresponding trim value must be loaded into TRIMVAL<6:0>.

There are two methods for determining the trim value. The first method involves measuring an output frequency directly and calculating the deviation from ideal. The second method involves observing the number of seconds gained or lost over a period of time.

Once the OSCTRIM register has been loaded, digital trimming will automatically occur every minute.

5.6.1.1 Calibration by Measuring Frequency

To calibrate the MCP7941X by measuring the output frequency, perform the following steps:

- 1. Enable the crystal oscillator or external clock input by setting the ST bit or EXTOSC bit, respectively.
- 2. Ensure TRIMVAL<6:0> is reset to 0x00.
- 3. Select an output frequency by setting SQWFS<1:0>.
- 4. Set SQWEN to enable the square wave output.
- 5. Measure the resulting output frequency using a calibrated measurement tool, such as a frequency counter.
- 6. Calculate the number of error clocks per minute (see Equation 5-2).

EQUATION 5-2: CALCULATING TRIM VALUE FROM MEASURED FREQUENCY

$$TRIMVAL < 6:0> = \frac{(FIDEAL - FMEAS) \cdot \frac{32768}{FIDEAL}}{2}$$

· 60

Where:

```
FIDEAL = Ideal frequency based on SQWFS<1:0>
FMEAS = Measured frequency
```

- If the number of error clocks per minute is negative, then the oscillator is *faster* than ideal and the SIGN bit must be cleared.
- If the number of error clocks per minute is positive, then the oscillator is *slower* than ideal and the SIGN bit must be set.
- 7. Load the correct value into TRIMVAL<6:0>.
 - **Note:** Using a lower output frequency and/or averaging the measured frequency over a number of clock pulses will reduce the effects of jitter and improve accuracy.

5.6.1.2 Calibration by Observing Time Deviation

To calibrate the MCP7941X by observing the deviation over time, perform the following steps:

- 1. Ensure TRIMVAL<6:0> is reset to 0x00.
- Load the timekeeping registers to synchronize the MCP7941X with a known-accurate reference time.
- Enable the crystal oscillator or external clock input by setting the ST bit or EXTOSC bit, respectively.
- 4. Observe how many seconds are gained or lost over a period of time (larger time periods offer more accuracy).
- 5. Calculate the PPM deviation (see Equation 5-3).

EQUATION 5-3: CALCULATING ERROR PPM

$$PPM = \frac{SecDeviation}{ExpectedSec} \cdot 1000000$$

Where:

ExpectedSec = Number of seconds in chosen period *SecDeviation* = Number of seconds gained or lost

- If the MCP7941X has gained time relative to the reference clock, then the oscillator is *faster* than ideal and the SIGN bit must be cleared.
- If the MCP7941X has lost time relative to the reference clock, then the oscillator is *slower* than ideal and the SIGN bit must be set.
- 6. Calculate the trim value (see Equation 5-4).

EQUATION 5-4: CALCULATING TRIM VALUE FROM ERROR PPM

 $TRIMVAL < 6:0> = \frac{PPM \cdot 32768 \cdot 60}{1000000 \cdot 2}$

7. Load the correct value into TRIMVAL<6:0>.

Note 1: Choosing a longer time period for observing deviation will improve accuracy.

2: Large temperature variations during the observation period can skew results.

5.6.2 COARSE TRIM MODE

When CRSTRIM = 1, Coarse Trim mode is enabled. While in this mode, the MCP7941X will apply trimming at a rate of 128 Hz. If SQWEN is set, the MFP will output a trimmed 64 Hz nominal clock signal.

Because trimming is applied at a rate of 128 Hz rather than once every minute, each step of the TRIMVAL<6:0> value has a significantly larger effect on the resulting time deviation and output clock frequency. By monitoring the MFP output frequency while in this mode, the user can easily observe the TRIMVAL<6:0> value affecting the clock timing.

Note 1: The 64 Hz Coarse Trim mode square wave output is not available while operating from the backup power supply.

> 2: With Coarse Trim mode enabled, the TRIMVAL<6:0> value has a drastic effect on timing. Leaving the mode enabled during normal operation will likely result in inaccurate time.

TABLE 5-12: SUMMARY OF REGISTERS ASSOCIATED WITH DIGITAL TRIMMING

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page
CONTROL	OUT	SQWEN	ALM1EN	ALM0EN	EXTOSC	CRSTRIM	SQWFS1	SQWFS0	27
OSCTRIM	SIGN	TRIMVAL6	TRIMVAL5	TRIMVAL4	TRIMVAL3	TRIMVAL2	TRIMVAL1	TRIMVAL0	30

Legend: — = unimplemented location, read as '0'. Shaded cells are not used by digital trimming.

5.7 Battery Backup

The MCP7941X features a backup power supply input (VBAT) that can be used to provide power to the timekeeping circuitry, RTCC registers, and SRAM while primary power is unavailable. The MCP7941X will automatically switch to backup power when VCC falls below VTRIP, and back to VCC when it is above VTRIP.

The VBATEN bit must be set to enable the VBAT input.

The following functionality is maintained while operating on backup power:

- Timekeeping
- Alarms
- Alarm Output
- Digital Trimming
- RTCC Register and SRAM Contents

The following features are not available while operating on backup power:

- I²C Communication
- Square Wave Clock Output
- General Purpose Output

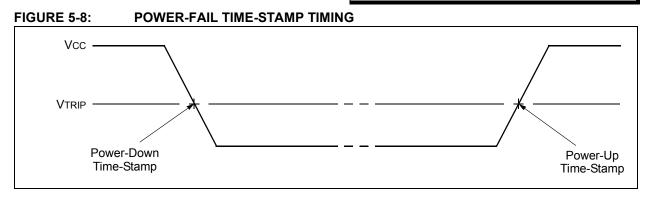
5.7.1 POWER-FAIL TIME-STAMP

The MCP7941X includes a power-fail time-stamp module that stores the minutes, hours, date, and month when primary power is lost and when it is restored (Figure 5-8). The PWRFAIL bit is also set to indicate that a power failure occurred.

Note: Throughout this section, references to the register and bit names for the Power-Fail Time-Stamp module are referred to generically by the use of 'x' in place of the specific module name. Thus, "PWRxxMIN" might refer to the minutes register for Power-Down or Power-Up.

To utilize the power-fail time-stamp feature, a backup power supply must be available with the VBAT input enabled, and the oscillator should also be running to ensure accurate functionality.

- **Note 1:** The PWRFAIL bit must be cleared to log new time-stamp data. This is to ensure previous time-stamp data is not lost.
 - **2:** Clearing the PWRFAIL bit will clear all time-stamp registers.



REGISTER 5-16: PWRxxMIN: POWER-DOWN/POWER-UP TIME-STAMP MINUTES VALUE REGISTER (ADDRESSES 0x18/0x1C)

U-0	R/W-0						
—	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0
bit 7							bit 0

Legend:					
R = Readable bit	W = Writable bit	U = Unimplemented b	U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown		

bit 7 Unimplemented: Read as '0'

bit 6-4	MINTEN<2:0>: Binary-Coded Decimal Value of Minute's Tens Digit
	Contains a value from 0 to 5
bit 3-0	MINONE<3:0>: Binary-Coded Decimal Value of Minute's Ones Digit
	Contains a value from 0 to 9

REGISTER 5-17: PWRxxHOUR: POWER-DOWN/POWER-UP TIME-STAMP HOURS VALUE REGISTER (ADDRESSES 0x19/0x1D)

U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0
bit 7							bit 0

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown	

If 12/24 = 1 (12-hour format):

$\frac{11}{12}$	<u>L-nour rormuty.</u>
bit 7	Unimplemented: Read as '0'
bit 6	12/24: 12 or 24 Hour Time Format bit
	1 = 12-hour format
	0 = 24-hour format
bit 5	AM/PM: AM/PM Indicator bit
	1 = PM
	0 = AM
bit 4	HRTEN0: Binary-Coded Decimal Value of Hour's Tens Digit
	Contains a value from 0 to 1
bit 3-0	HRONE<3:0>: Binary-Coded Decimal Value of Hour's Ones Digit
	Contains a value from 0 to 9
<u>If 12/24 = 0 (24</u>	4-hour format):
bit 7	Unimplemented: Read as '0'
bit 6	12/24: 12 or 24 Hour Time Format bit
	1 = 12-hour format
	0 = 24-hour format
bit 5-4	HRTEN<1:0>: Binary-Coded Decimal Value of Hour's Tens Digit
	Contains a value from 0 to 2.
bit 3-0	HRONE<3:0>: Binary-Coded Decimal Value of Hour's Ones Digit
	Contains a value from 0 to 9

REGISTER 5-18: PWRxxDATE: POWER-DOWN/POWER-UP TIME-STAMP DATE VALUE REGISTER (ADDRESSES 0x1A/0x1E)

U-0	U-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
—	—	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0
bit 7							bit 0

Legend:				
R = Readable bit W = Writable bit		U = Unimplemented bit, read as '0'		
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown	

bit 7-6	Unimplemented: Read as '0'
bit 5-4	DATETEN<1:0>: Binary-Coded Decimal Value of Date's Tens Digit
	Contains a value from 0 to 3
bit 3-0	DATEONE<3:0>: Binary-Coded Decimal Value of Date's Ones Digit
	Contains a value from 0 to 9

REGISTER 5-19: PWRxxMTH: POWER-DOWN/POWER-UP TIME-STAMP MONTH VALUE REGISTER (ADDRESSES 0x1B/0x1F)

R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0	R/W-0
WKDAY2	WKDAY1	WKDAY0	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0
bit 7							bit 0

Legend:						
R = Readable bit	W = Writable bit	ritable bit U = Unimplemented bit, read as '0'				
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	x = Bit is unknown			

bit 7-5	WKDAY<2:0>: Binary-Coded Decimal Value of Day bits					
	Contains a value from 1 to 7. The representation is user-defined.					
bit 4	MTHTEN0: Binary-Coded Decimal Value of Month's Ones Digit					
	Contains a value of 0 or 1					
bit 3-0	MTHONE<3:0>: Binary-Coded Decimal Value of Month's Ones Digit					

Contains a value from 0 to 9

TABLE 5-13: SUMMARY OF REGISTERS ASSOCIATED WITH BATTERY BACKUP

Name	Bit 7	Bit 6	Bit 5	Bit 4	Bit 3	Bit 2	Bit 1	Bit 0	Register on Page	
RTCWKDAY	_	_	OSCRUN	PWRFAIL	VBATEN	WKDAY2	WKDAY1	WKDAY0	19	
PWRDNMIN	_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0	34	
PWRDNHOUR	_	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0	34	
PWRDNDATE	_	_	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0	35	
PWRDNMTH	WKDAY2	WKDAY1	WKDAY0	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0	35	
PWRUPMIN	_	MINTEN2	MINTEN1	MINTEN0	MINONE3	MINONE2	MINONE1	MINONE0	34	
PWRUPHOUR	_	12/24	AM/PM HRTEN1	HRTEN0	HRONE3	HRONE2	HRONE1	HRONE0	34	
PWRUPDATE	_	_	DATETEN1	DATETEN0	DATEONE3	DATEONE2	DATEONE1	DATEONE0	35	
PWRUPMTH	WKDAY2	WKDAY1	WKDAY0	MTHTEN0	MTHONE3	MTHONE2	MTHONE1	MTHONE0	35	

Legend: — = unimplemented location, read as '0'. Shaded cells are not used with battery backup.

6.0 ON-BOARD MEMORY

The MCP7941X has 1 Kbits (128 bytes) of EEPROM, eight bytes of protected EEPROM for storing crucial information, and 64 bytes of SRAM for general purpose usage. The SRAM is retained when the primary power supply is removed if a backup supply is present and enabled. Since the EEPROM is nonvolatile, it does not require a supply for data retention.

Although the SRAM is a separate block from the RTCC registers, they are accessed using the same control byte, '1101111X'. The EEPROM is in a different address space and requires the use of a different control byte, '1010111X'. RTCC and SRAM can be accessed for reads or writes immediately after starting an EEPROM write cycle.

6.1 SRAM/RTCC Registers

The RTCC registers are located at addresses 0x00 to 0x1F, and the SRAM is located at addresses 0x20 to 0x5F. The SRAM can be accessed while the RTCC registers are being internally updated. The SRAM is not initialized by a Power-On Reset (POR).

Neither the RTCC registers nor the SRAM can be accessed when the device is operating off the backup power supply.

6.1.1 SRAM/RTCC REGISTER BYTE WRITE

Following the Start condition from the master, the control code and the R/W bit (which is a logic low) are clocked onto the bus by the master transmitter. This indicates to the addressed slave receiver that the address byte will follow after it has generated an Acknowledge bit during the ninth clock cycle. Thereaddress and will be written into the Address Pointer of the MCP7941X. After receiving another Acknowledge bit from the MCP7941X, the master device transmits the data byte to be written into the addressed memory location. The MCP7941X stores the data byte into memory and acknowledges again, and the master generates a Stop condition (Figure 6-1).

fore, the next byte transmitted by the master is the

If an attempt is made to write to an address past 0x5F, the MCP7941X will not acknowledge the address or data bytes, and no data will be written. After a byte Write command, the internal Address Pointer will point to the address location following the one that was just written.

6.1.2 SRAM/RTCC REGISTER SEQUENTIAL WRITE

The write control byte, address, and the first data byte are transmitted to the MCP7941X in the same way as in a byte write. But instead of generating a Stop condition, the master transmits additional data bytes. Upon receipt of each byte, the MCP7941X responds with an Acknowledge, during which the data is latched into memory and the Address Pointer is internally incremented by one. As with the byte write operation, the master ends the command by generating a Stop condition (Figure 6-2).

There is no limit to the number of bytes that can be written in a single command. However, because the RTCC registers and SRAM are separate blocks, writing past the end of each block will cause the Address Pointer to roll over to the beginning of the same block. Specifically, the Address Pointer will roll over from 0x1F to 0x00, and from 0x5F to 0x20.

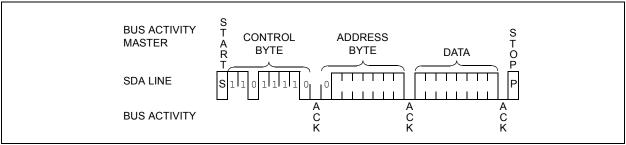
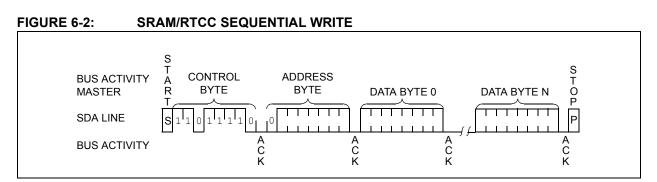


FIGURE 6-1: SRAM/RTCC BYTE WRITE



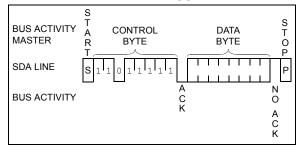
6.1.3 SRAM/RTCC REGISTER CURRENT ADDRESS READ

The MCP7941X contains an address counter that maintains the address of the last byte accessed, internally incremented by one. Therefore, if the previous read access was to address n (n is any legal address), the next current address read operation would access data from address n + 1.

Upon receipt of the control byte with R/\overline{W} bit set to '1', the MCP7941X issues an Acknowledge and transmits the 8-bit data word. The master will not acknowledge the transfer but does generate a Stop condition and the MCP7941X discontinues transmission (Figure 6-3).

Note:	The Address Pointer is shared between
	the SRAM/RTCC registers and the
	EEPROM.

FIGURE 6-3: SRAM/RTCC CURRENT ADDRESS READ



6.1.4 SRAM/RTCC REGISTER RANDOM READ

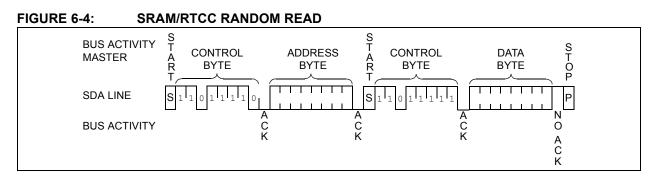
Random read operations allow the master to access any memory location in a random manner. To perform this type of read operation, first the address must be set. This is done by sending the address to the MCP7941X as part of a write operation (R/\overline{W} bit set to '0'). After the address is sent, the master generates a Start condition following the Acknowledge. This terminates the write operation, but not before the internal Address Pointer is set. Then, the master issues the control byte again but with the R/\overline{W} bit set to a '1'. The MCP7941X will then issue an Acknowledge and transmit the 8-bit data word. The master will not acknowledge the transfer but it does generate a Stop condition which causes the MCP7941X to discontinue transmission (Figure 6-4). After a random Read command, the internal address counter will point to the address location following the one that was just read.

6.1.5 SRAM/RTCC REGISTER SEQUENTIAL READ

Sequential reads are initiated in the same way as a random read except that after the MCP7941X transmits the first data byte, the master issues an Acknowledge as opposed to the Stop condition used in a random read. This Acknowledge directs the MCP7941X to transmit the next sequentially addressed 8-bit word (Figure 6-5). Following the final byte transmitted to the master, the master will NOT generate an Acknowledge but will generate a Stop condition. To provide sequential reads, the MCP7941X contains an internal Address Pointer which is incremented by one at the completion of each operation. This Address Pointer allows the entire memory block to be serially read during one operation.

Because the RTCC registers and SRAM are separate blocks, reading past the end of each block will cause the Address Pointer to roll over to the beginning of the same block. Specifically, the Address Pointer will roll over from 0x1F to 0x00, and from 0x5F to 0x20.

^{© 2010-2014} Microchip Technology Inc.



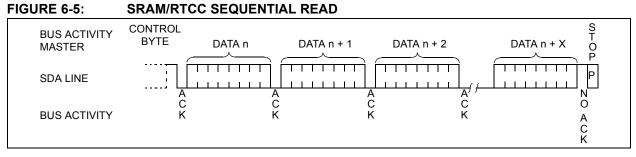


TABLE 6-1:

6.2 EEPROM

The MCP7941X features 1 Kbits of EEPROM organized in 8-byte pages with software write protection configured through the STATUS register.

6.2.1 STATUS REGISTER

The STATUS register contains bits BP<1:0> which are used to set the block write protection for the EEPROM array.

The STATUS register is a nonvolatile Control register in the EEPROM address space at location 0xFF. The STATUS register is accessed using control byte '1010111x'. Setting the BP<1:0> bits in the STATUS register determines which regions are protected in the EEPROM array per Table 6-1.

If multiple bytes are loaded to the STATUS register, only the last byte is written. The write to the STATUS register is initiated by the I²C Stop condition.

BP1	BP0	Array Addresses Write-Protected
0	0	None
0	1	Upper 1/4 (60h-7Fh)
1	0	Upper 1/2 (40h-7Fh)
1	1	All (00h-7Fh)

BLOCK PROTECTION

REGISTER 6-1: STATUS: EEPROM BLOCK PROTECTION CONTROL REGISTER (ADDRESS 0xFF)

U	U	U	U	R/W-0	R/W-0	U	U
—	_	—	_	BP1	BP0	—	—
bit 7							bit 0

Legend:			
R = Readable bit	W = Writable bit	U = Unimplemented bi	it, read as '0'
-n = Value at POR	'1' = Bit is set	'0' = Bit is clear	X = Bit is unknown

bit 7-4 Unimplemented: Read as '0'

bit 3-2 BP<1:0>: EEPROM Array Block Protection bits

bit 1-0 Unimplemented: Read as '0'

6.2.2 EEPROM BYTE WRITE

Following the Start condition from the master, the control code and the R/W bit (which is a logic low) are clocked onto the bus by the master transmitter. This indicates to the addressed slave receiver that the address byte will follow after it has generated an Acknowledge bit during the ninth clock cycle. Therefore, the next byte transmitted by the master is the address and will be written into the Address Pointer of the MCP7941X. After receiving another Acknowledge bit from the MCP7941X, the master device transmits the data byte to be written into the addressed memory location. The MCP7941X acknowledges again and the master generates a Stop condition. This initiates the internal write cycle and, during this time, the MCP7941X does not generate Acknowledge signals for EEPROM commands. Access to the RTCC registers and SRAM is still possible during an EEPROM write cycle.

If an attempt is made to write to an address outside of the defined regions, the MCP7941X will not acknowledge the address or data bytes, no data will be written, and the device will immediately accept a new command. After a Byte Write command, the internal Address Pointer will point to the address location following the one that was just written.

6.2.3 EEPROM SEQUENTIAL WRITE

The write control byte, word address, and the first data byte are transmitted to the MCP7941X in the same way as in a byte write. But instead of generating a Stop condition, the master transmits up to seven additional bytes, which are temporarily stored in the on-chip page buffer and will be written into memory after the master has transmitted a Stop condition. After receipt of each word, the three lower Address Pointer bits are internally incremented by one. If the master should transmit more than eight bytes prior to generating the Stop condition, the address counter will roll over and the data received previously will be overwritten. As with the byte write operation, once the Stop condition is received, an internal write cycle will begin (Figure 6-7).

FIGURE 6-6: EEPROM BYTE WRITE

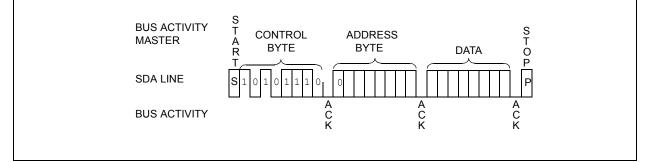
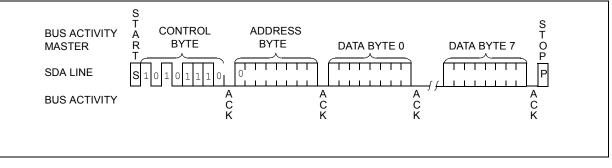


FIGURE 6-7: EEPROM PAGE WRITE

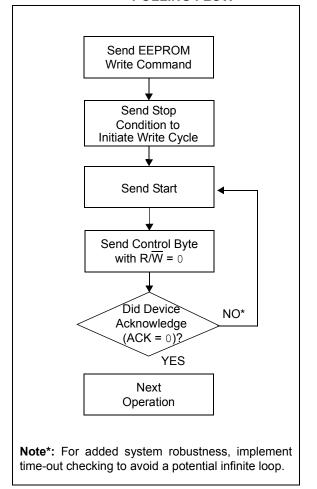


6.2.4 ACKNOWLEDGE POLLING

Since the device will not acknowledge an EEPROM control byte during an internal EEPROM write cycle, this can be used to determine when the cycle is complete. This feature can be used to maximize bus throughput. Once the Stop condition for a Write command has been issued from the master, the device initiates the internally timed write cycle. ACK polling can be initiated immediately. This involves the master sending a Start condition, followed by the control byte for a Write command (R/W = 0). If the device is still busy with the write cycle, then no ACK will be returned. If no ACK is returned, then the Start bit and control byte must be resent. If the cycle is complete, then the device will return the ACK, and the master can then proceed with the next Read or Write command. See Figure 6-8 for the flow diagram.

FIGURE 6-8: ACKNOWLEDGE

POLLING FLOW



Note: For added systems robustness, it is recommended that time-out functionality be implemented in the acknowledge polling routine to avoid potentially hanging the system by entering an infinite loop. This can easily be done by designing in a maximum number of loops the routine will execute, or through the use of a hardware timer. If a time out occurs, polling should be aborted by sending a Stop condition. A user-generated error-handling routine can then be called, allowing the system to recover in a manner appropriate for the application.

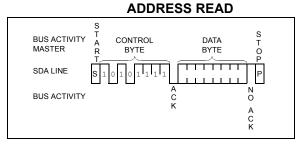
6.2.5 EEPROM CURRENT ADDRESS READ

The MCP7941X contains an address counter that maintains the address of the last byte accessed, internally incremented by one. Therefore, if the previous read access was to address n (n is any legal address), the next current address read operation would access data from address n + 1.

Upon receipt of the control byte with R/W bit set to '1', the MCP7941X issues an Acknowledge and transmits the 8-bit data word. The master will not acknowledge the transfer but does generate a Stop condition and the MCP7941X discontinues transmission (Figure 6-9).

Note:	The Address Pointer is shared between
	the SRAM/RTCC registers and the
	EEPROM.

FIGURE 6-9: EEPROM CURRENT



6.2.6 EEPROM RANDOM READ

Random read operations allow the master to access any EEPROM location in a random manner. To perform this type of read operation, first the address must be

FIGURE 6-10: EEPROM RANDOM READ

set. This is done by sending the address to the MCP7941X as part of a write operation (R/W bit set to '0'). After the address is sent, the master generates a Start condition following the Acknowledge. This terminates the write operation, but not before the internal Address Pointer is set. Then, the master issues the control byte again but with the R/W bit set to a '1'. The MCP7941X will then issue an Acknowledge and transmit the 8-bit data word. The master will not acknowledge the transfer but it does generate a Stop condition which causes the MCP7941X to discontinue transmission (Figure 6-10). After a random Read command, the internal address counter will point to the address location following the one that was just read.

6.2.7 EEPROM SEQUENTIAL READ

Sequential reads are initiated in the same way as a random read except that after the MCP7941X transmits the first data byte, the master issues an Acknowledge as opposed to the Stop condition used in a random read. This Acknowledge directs the MCP7941X to transmit the next sequentially addressed 8-bit word (Figure 6-11). Following the final byte transmitted to the master, the master will NOT generate an Acknowledge but will generate a Stop condition. To provide sequential reads, the MCP7941X contains an internal Address Pointer which is incremented by one at the completion of each operation. This Address Pointer allows the entire EEPROM block to be serially read during one operation. The internal Address pointer will automatically roll over from address 0x7F to address 0x00 if the master acknowledges the byte received from address 0x7F.

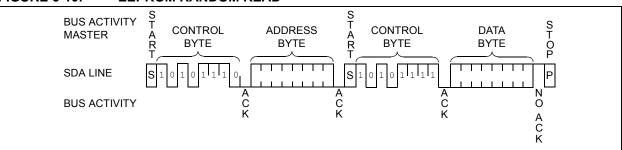
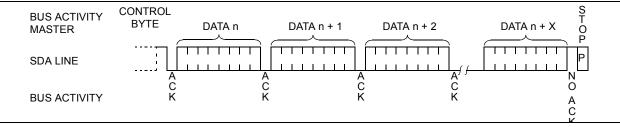


FIGURE 6-11: EEPROM SEQUENTIAL READ



6.3 Protected EEPROM

The MCP7941X features a 64-bit protected EEPROM block that requires a special unlock sequence to be followed in order to write to the memory. Note that reading from the memory does not require the unlock sequence to be performed. The protected EEPROM can be used for storing crucial information such as a unique serial number. The MCP79411 and MCP79412 include an EUI-48 and EUI-64 node address, respectively, preprogrammed into the protected EEPROM block. Custom programming is also available.

The protected EEPROM block is located at addresses 0xF0 to 0xF7 and is accessed using the '1010111x' control byte.

Note: Attempts to access invalid addresses (Figure 5-1) will result in the MCP7941X not acknowledging the address..

6.3.1 PROTECTED EEPROM UNLOCK SEQUENCE

The protected EEPROM block requires a special unlock sequence to prevent unintended writes, utilizing the EEUNLOCK register. The EEUNLOCK register is not a physical register; it is used exclusively in the EEPROM write sequence. Reading from EEUNLOCK will read all 0's.

To unlock the block, the following sequence must be followed:

- 1. Write 0x55 to the EEUNLOCK register
- 2. Write 0xAA to the EEUNLOCK register
- 3. Write the desired data bytes to the EEPROM

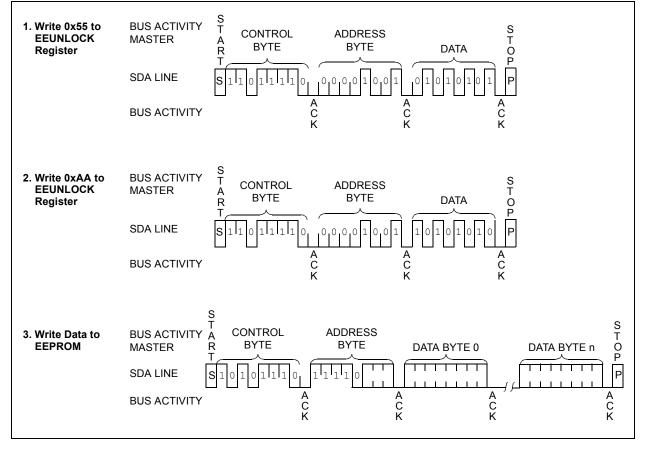
Figure 6-12 illustrates the sequence.

Note 1: Diverging from any step of the unlock sequence may result in the EEPROM remaining locked and the write operation being ignored.

2: Unlocking the EEPROM is not required in order to read from the memory.

The entire EEPROM block does not have to be written in a single operation. However, the block is locked after each write operation and must be unlocked again to start a new Write command.

FIGURE 6-12: PROTECTED EEPROM UNLOCK AND SEQUENTIAL WRITE



© 2010-2014 Microchip Technology Inc.

6.4 Pre-Programmed EUI-48[™] or EUI-64[™] Node Address

The MCP79411 and MCP79412 are programmed at the factory with a globally unique node address stored in the protected EEPROM block.

6.4.1 EUI-48™ NODE ADDRESS (MCP79411)

The 6-byte EUI-48[™] node address value of the MCP79411 is stored in EEPROM locations 0xF2 through 0xF7, as shown in Figure 6-13. The first three bytes are the Organizationally Unique Identifier (OUI) assigned to Microchip by the IEEE Registration Authority. Currently, Microchip's OUIs are 0x0004A3 and 0x001EC0, though this will change as addresses are exhausted. The remaining three bytes are the Extension Identifier, and are generated by Microchip to ensure a globally-unique, 48-bit value.

6.4.1.1 EUI-64[™] Support Using the MCP79411

The pre-programmed EUI-48 node address of the MCP79411 can easily be encapsulated at the application level to form a globally unique, 64-bit node address for systems utilizing the EUI-64 standard. This is done by adding 0xFFFE between the OUI and the Extension Identifier, as shown below.

Note: As an alternative, the MCP79412 features an EUI-64 node address that can be used in EUI-64 applications directly without the need for encapsulation, thereby simplifying system software. See Section 6.4.2 "EUI-64[™] Node Address (MCP79412)" for details.

6.4.2 EUI-64[™] NODE ADDRESS (MCP79412)

The 8-byte EUI-64[™] node address value of the MCP79412 is stored in array locations 0xF0 through 0xF7, as shown in Figure 6-14. The first three bytes are the Organizationally Unique Identifier (OUI) assigned to Microchip by the IEEE Registration Authority. Currently, Microchip's OUIs are 0x0004A3 and 0x001EC0, though this will change as addresses are exhausted. The remaining five bytes are the Extension Identifier, and are generated by Microchip to ensure a globally-unique, 64-bit value.

FIGURE 6-13: EUI-48 NODE ADDRESS PHYSICAL MEMORY MAP EXAMPLE (MCP79411)

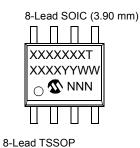
Description		t Organizatio nique Identifi		24	24-bit Extension Identifier	
Data	00h	04h	A3h	12h	34h	56h
Array Address	F2h			<u> </u>		F7h

Note: In conformance with IEEE guidelines, Microchip will not use the values 0xFFFE and 0xFFFF for the first two bytes of the EUI-64 Extension Identifier. These two values are specifically reserved to allow applications to encapsulate EUI-48 addresses into EUI-64 addresses.

FIGURE 6-14:	EUI-64	4 NODE AI	DDRESS P	HYSICAL	MEMORY	MAP EXAN	IPLE (MCF	P79412)
Description	24-bit Organizationally40-bit ExtensionUnique IdentifierIdentifier							
Data	00h	04h	A3h	12h	34h	56h	78h	90h
Array Address	F0h							F7h
Corresponding EUI-64™ Node Address: 00-04-A3-12-34-56-78-90								

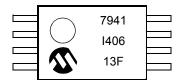
7.0 PACKAGING INFORMATION

7.1 Package Marking Information

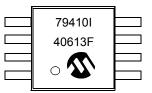


Example:

Example:



Example:



Example:



Part Number	1st Line Marking Codes						
Part Number	SOIC	TSSOP	MSOP	TDFN			
MCP79410	79410T	7941	79410T	AAP			
MCP79411	79411T	9411	79411T	AAQ			
MCP79412	79412T	9412	79412T	AAR			

T = Temperature grade

Legend	: XXX Y YY WW NNN @3 *	Customer-specific information Year code (last digit of calendar year) Year code (last 2 digits of calendar year) Week code (week of January 1 is week '01') Alphanumeric traceability code JEDEC [®] designator for Matte Tin (Sn) This package is RoHs compliant. The JEDEC designator (e3) can be found on the outer packaging for this package.
	be carrie	nt the full Microchip part number cannot be marked on one line, it will d over to the next line, thus limiting the number of available s for customer-specific information.



8-Lead MSOP

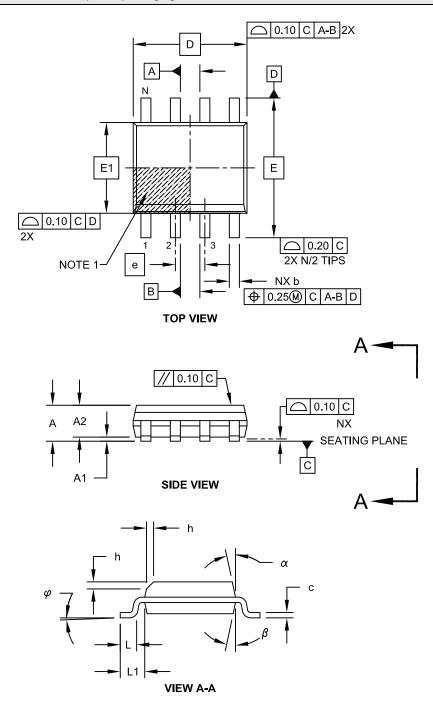


8-Lead 2x3 TDFN



8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

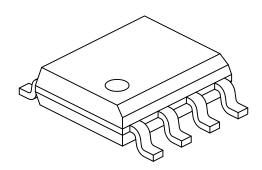
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing No. C04-057C Sheet 1 of 2

8-Lead Plastic Small Outline (SN) - Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	N	MILLIMETERS					
Dimensio	n Limits	MIN	NOM	MAX			
Number of Pins	Ν		8				
Pitch	е		1.27 BSC				
Overall Height	А	-	-	1.75			
Molded Package Thickness	A2	1.25	-	I			
Standoff §	A1	0.10	-	0.25			
Overall Width	E	6.00 BSC					
Molded Package Width	E1	3.90 BSC					
Overall Length	D	4.90 BSC					
Chamfer (Optional)	h	0.25	-	0.50			
Foot Length	L	0.40	-	1.27			
Footprint	L1		1.04 REF				
Foot Angle	φ	0°	-	8°			
Lead Thickness	С	0.17	-	0.25			
Lead Width	b	0.31	-	0.51			
Mold Draft Angle Top	α	5°	-	15°			
Mold Draft Angle Bottom	β	5°	-	15°			

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. § Significant Characteristic

- 3. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15mm per side.
- 4. Dimensioning and tolerancing per ASME Y14.5M

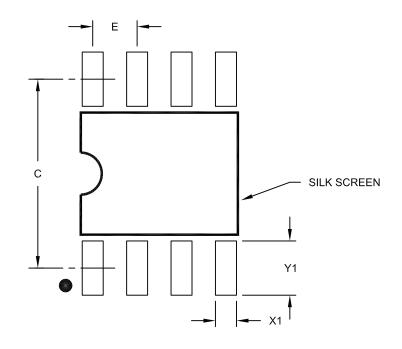
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-057C Sheet 2 of 2

8-Lead Plastic Small Outline (SN) – Narrow, 3.90 mm Body [SOIC]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	MILLIMETERS			
Dimension	MIN	NOM	MAX	
Contact Pitch	E		1.27 BSC	
Contact Pad Spacing	С		5.40	
Contact Pad Width (X8)	X1			0.60
Contact Pad Length (X8)	Y1			1.55

Notes:

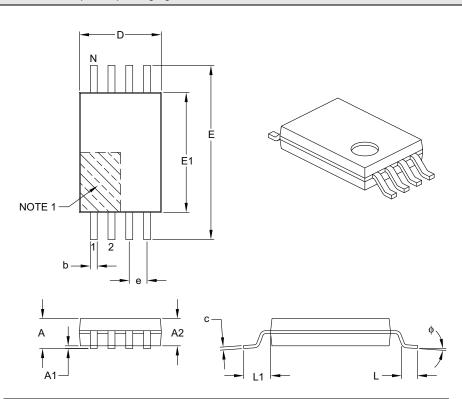
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2057A

8-Lead Plastic Thin Shrink Small Outline (ST) – 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



	Units			5
Dimension	Dimension Limits		NOM	MAX
Number of Pins		8		
Pitch	е		0.65 BSC	
Overall Height	Α	-	-	1.20
Molded Package Thickness	A2	0.80	1.00	1.05
Standoff	A1	0.05	-	0.15
Overall Width	E	6.40 BSC		
Molded Package Width	E1	4.30	4.40	4.50
Molded Package Length	D	2.90	3.00	3.10
Foot Length	L	0.45	0.60	0.75
Footprint	L1		1.00 REF	
Foot Angle	φ	0°	-	8°
Lead Thickness	с	0.09	-	0.20
Lead Width	b	0.19	-	0.30

Notes:

1. Pin 1 visual index feature may vary, but must be located within the hatched area.

2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or protrusions shall not exceed 0.15 mm per side.

3. Dimensioning and tolerancing per ASME Y14.5M.

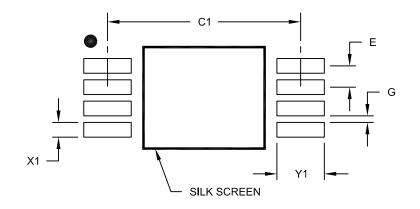
BSC: Basic Dimension. Theoretically exact value shown without tolerances.

REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-086B

8-Lead Plastic Thin Shrink Small Outline (ST) - 4.4 mm Body [TSSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Contact Pitch	E	0.65 BSC		
Contact Pad Spacing	C1		5.90	
Contact Pad Width (X8)	X1			0.45
Contact Pad Length (X8)	Y1			1.45
Distance Between Pads	G	0.20		

Notes:

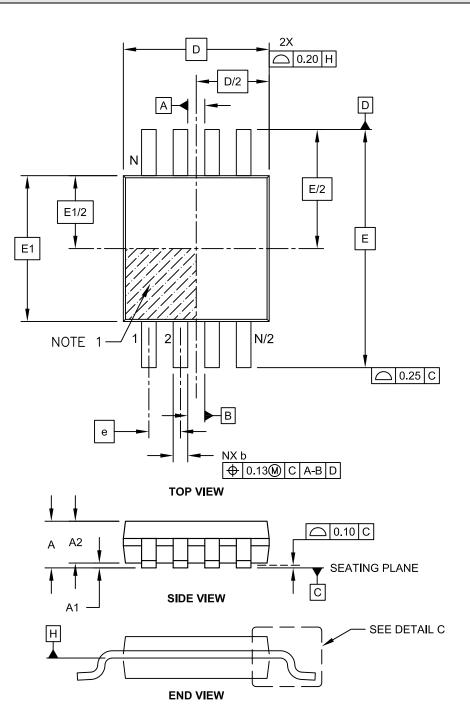
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2086A

8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

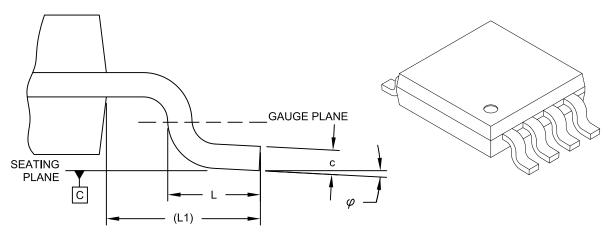
Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Microchip Technology Drawing C04-111C Sheet 1 of 2

8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



DETAIL C

Units		MILLIMETERS		
Dimension Limits		MIN	NOM	MAX
Number of Pins	N		8	
Pitch	е	0.65 BSC		
Overall Height	A	-	-	1.10
Molded Package Thickness	A2	0.75	0.85	0.95
Standoff	A1	0.00	-	0.15
Overall Width	E	4.90 BSC		
Molded Package Width	E1	3.00 BSC		
Overall Length	D	3.00 BSC		
Foot Length	L	0.40	0.60	0.80
Footprint	L1	0.95 REF		
Foot Angle	φ	0°	-	8°
Lead Thickness	С	0.08	-	0.23
Lead Width	b	0.22	-	0.40

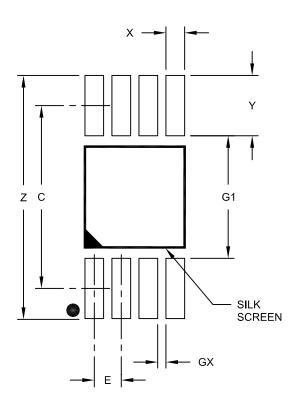
Notes:

- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Dimensions D and E1 do not include mold flash or protrusions. Mold flash or
- protrusions shall not exceed 0.15mm per side.
- 3. Dimensioning and tolerancing per ASME Y14.5M.
 - BSC: Basic Dimension. Theoretically exact value shown without tolerances.
 - REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing C04-111C Sheet 2 of 2

8-Lead Plastic Micro Small Outline Package (MS) [MSOP]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



RECOMMENDED LAND PATTERN

	Units		MILLIMETERS		
Dimensior	Dimension Limits		NOM	MAX	
Contact Pitch	E	0.65 BSC			
Contact Pad Spacing	С		4.40		
Overall Width	Z			5.85	
Contact Pad Width (X8)	X1			0.45	
Contact Pad Length (X8)	Y1			1.45	
Distance Between Pads	G1	2.95			
Distance Between Pads	GX	0.20			

Notes:

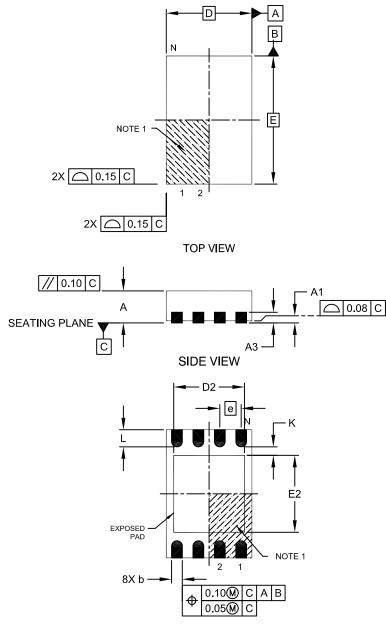
1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2111A

8-Lead Plastic Dual Flat, No Lead Package (MN) – 2x3x0.75mm Body [TDFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging

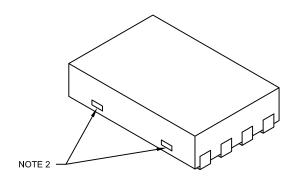


BOTTOM VIEW

Microchip Technology Drawing No. C04-129C

8-Lead Plastic Dual Flat, No Lead Package (MN) – 2x3x0.75mm Body [TDFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Number of Pins	N	8			
Pitch	е		0.50 BSC		
Overall Height	A	0.70	0.75	0.80	
Standoff	A1	0.00	0.02	0.05	
Contact Thickness	A3	0.20 REF			
Overall Length	D	2.00 BSC			
Overall Width	E	3.00 BSC			
Exposed Pad Length	D2	1.20	-	1.60	
Exposed Pad Width	E2	1.20	-	1.60	
Contact Width	b	0.20	0.25	0.30	
Contact Length	L	0.25	0.30	0.45	
Contact-to-Exposed Pad	K	0.20	-	-	

Notes:

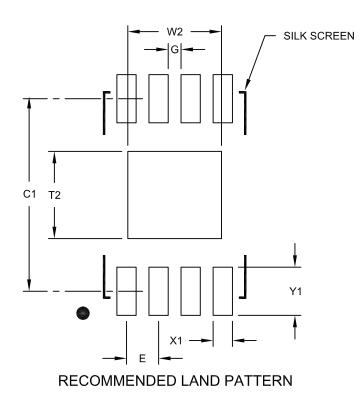
- 1. Pin 1 visual index feature may vary, but must be located within the hatched area.
- 2. Package may have one or more exposed tie bars at ends.
- 3. Package is saw singulated
- 4. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances. REF: Reference Dimension, usually without tolerance, for information purposes only.

Microchip Technology Drawing No. C04-129C Sheet 2 of 2

8-Lead Plastic Dual Flat, No Lead Package (MN) – 2x3x0.75 mm Body [TDFN]

Note: For the most current package drawings, please see the Microchip Packaging Specification located at http://www.microchip.com/packaging



Units		MILLIMETERS			
Dimension Limits		MIN	NOM	MAX	
Contact Pitch	E		0.50 BSC		
Optional Center Pad Width	W2			1.46	
Optional Center Pad Length	T2			1.36	
Contact Pad Spacing	C1		3.00		
Contact Pad Width (X8)	X1			0.30	
Contact Pad Length (X8)	Y1			0.75	
Distance Between Pads	G	0.20			

Notes:

1. Dimensioning and tolerancing per ASME Y14.5M

BSC: Basic Dimension. Theoretically exact value shown without tolerances.

Microchip Technology Drawing No. C04-2129A

APPENDIX A: REVISION HISTORY

Revision A (10/2010)

Original release of this document.

Revision B (03/2011)

Minor typographical edits; Added Appendix B: Device Errata

Revision C (07/2011)

Updated Section 4.2.6, Crystal Specs; Revised Figure 4-4.

Revision D (12/2011)

Added DC/AC Char. Charts

Revision E (04/2013)

Revised Features page; Revised Schematic, Block Diagram; Added detailed descriptions for Registers.

Minor updates to the overall content.

Revision F (03/2014)

Updated overall content for improved clarity. Added detailed descriptions of registers. Updated block diagram and application schematic.

TABLE 7-2:DC CHARACTERISTIC NAME CHANGES

Old Name Old Symbol **New Name** New Symbol Operating current EEPROM EEPROM operating current Icc Read **ICCEERD** Icc Write **ICCEEWR** Operating current SRAM Icc Read SRAM/RTCC register operating current **ICCREAD** Icc Write **I**CCWRITE Operating current Ivcc Timekeeping current Ісст Timekeeping backup current **I**BAT **I**BATT Standby current Iccs Vcc data retention current (oscillator off) **ICCDAT**

Defined names for all bits and registers, and renamed the bits shown in Table 7-1 for clarification.

Renamed the DC characteristics shown in Table 7-2 for clarification.

TADLE /-1. DIT NAME CHANGES				
New Bit Name				
OSCRUN				
PWRFAIL				
LPYR				
SQWEN				
ALM0EN				
ALM1EN				
SQWFS0				
SQWFS1				
CRSTRIM				
TRIMVAL<6:0>				
ALMPOL				
ALMPOL				
ALM0MSK<2:0>				
ALM1MSK<2:0>				

TABLE 7-1: BIT NAME CHANGES

THE MICROCHIP WEB SITE

Microchip provides online support via our WWW site at www.microchip.com. This web site is used as a means to make files and information easily available to customers. Accessible by using your favorite Internet browser, the web site contains the following information:

- Product Support Data sheets and errata, application notes and sample programs, design resources, user's guides and hardware support documents, latest software releases and archived software
- General Technical Support Frequently Asked Questions (FAQ), technical support requests, online discussion groups, Microchip consultant program member listing
- Business of Microchip Product selector and ordering guides, latest Microchip press releases, listing of seminars and events, listings of Microchip sales offices, distributors and factory representatives

CUSTOMER CHANGE NOTIFICATION SERVICE

Microchip's customer notification service helps keep customers current on Microchip products. Subscribers will receive e-mail notification whenever there are changes, updates, revisions or errata related to a specified product family or development tool of interest.

To register, access the Microchip web site at www.microchip.com. Under "Support", click on "Customer Change Notification" and follow the registration instructions.

CUSTOMER SUPPORT

Users of Microchip products can receive assistance through several channels:

- Distributor or Representative
- Local Sales Office
- Field Application Engineer (FAE)
- Technical Support

Customers should contact their distributor, representative or Field Application Engineer (FAE) for support. Local sales offices are also available to help customers. A listing of sales offices and locations is included in the back of this document.

Technical support is available through the web site at: http://microchip.com/support

NOTES:

PRODUCT IDENTIFICATION SYSTEM

To order or obtain information, e.g., on pricing or delivery, refer to the factory or the listed sales office. Not every possible ordering combination is listed below.

PART NO	<u>. × /xx</u>	Examples:
Device	Range MCP79410 = 1.8V - 5.5V I ² C™ Serial RTCC MCP79410T = 1.8V - 5.5V I ² C Serial RTCC (Tape and Reel) MCP79411 = 1.8V - 5.5V I ² C Serial RTCC, EUI-48 TM	 a) MCP79410-I/SN: Industrial Temperature, SOIC package. b) MCP79410T-I/SN: Industrial Tempera- ture, SOIC package, Tape and Reel. c) MCP79410T-I/MNY: Industrial Tempera- ture, TDFN package, Tape and Reel. d) MCP79411-I/SN: Industrial Temperature,
Temperature Range:	$\begin{array}{rcl} \text{MCP79411T} & 1.8\text{V} - 5.5\text{V} \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \ \$	 sOIC package, EUI-48TM. e) MCP79411-I/MS: Industrial Temperature MSOP package, EUI-48TM. f) MCP79412-I/SN: Industrial Temperature, SOIC package, EUI-64TM. g) MCP79412-I/ST: Industrial Temperature, TSSOP package, EUI-64TM. h) MCP79412T-I/ST: Industrial Temperature, TSSOP package, Tape and Reel, MCP79412T-I/ST
Package: Note 1: "Y	SN = 8-Lead Plastic Small Outline (3.90 mm body) ST = 8-Lead Plastic Thin Shrink Small Outline (4.4 mm) MS = 8-Lead Plastic Micro Small Outline MNY ⁽¹⁾ = 8-Lead Plastic Dual Flat, No Lead	EUI-64 TM .

NOTES:

Note the following details of the code protection feature on Microchip devices:

- Microchip products meet the specification contained in their particular Microchip Data Sheet.
- Microchip believes that its family of products is one of the most secure families of its kind on the market today, when used in the intended manner and under normal conditions.
- There are dishonest and possibly illegal methods used to breach the code protection feature. All of these methods, to our knowledge, require using the Microchip products in a manner outside the operating specifications contained in Microchip's Data Sheets. Most likely, the person doing so is engaged in theft of intellectual property.
- Microchip is willing to work with the customer who is concerned about the integrity of their code.
- Neither Microchip nor any other semiconductor manufacturer can guarantee the security of their code. Code protection does not mean that we are guaranteeing the product as "unbreakable."

Code protection is constantly evolving. We at Microchip are committed to continuously improving the code protection features of our products. Attempts to break Microchip's code protection feature may be a violation of the Digital Millennium Copyright Act. If such acts allow unauthorized access to your software or other copyrighted work, you may have a right to sue for relief under that Act.

Information contained in this publication regarding device applications and the like is provided only for your convenience and may be superseded by updates. It is your responsibility to ensure that your application meets with your specifications. MICROCHIP MAKES NO REPRESENTATIONS OR WARRANTIES OF ANY KIND WHETHER EXPRESS OR IMPLIED, WRITTEN OR ORAL, STATUTORY OR OTHERWISE, RELATED TO THE INFORMATION, INCLUDING BUT NOT LIMITED TO ITS CONDITION, QUALITY, PERFORMANCE, MERCHANTABILITY OR FITNESS FOR PURPOSE. Microchip disclaims all liability arising from this information and its use. Use of Microchip devices in life support and/or safety applications is entirely at the buyer's risk, and the buyer agrees to defend, indemnify and hold harmless Microchip from any and all damages, claims, suits, or expenses resulting from such use. No licenses are conveyed, implicitly or otherwise, under any Microchip intellectual property rights.

QUALITY MANAGEMENT SYSTEM CERTIFIED BY DNV = ISO/TS 16949=

Trademarks

The Microchip name and logo, the Microchip logo, dsPIC, FlashFlex, KEELOQ, KEELOQ logo, MPLAB, PIC, PICmicro, PICSTART, PIC³² logo, rfPIC, SST, SST Logo, SuperFlash and UNI/O are registered trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

FilterLab, Hampshire, HI-TECH C, Linear Active Thermistor, MTP, SEEVAL and The Embedded Control Solutions Company are registered trademarks of Microchip Technology Incorporated in the U.S.A.

Silicon Storage Technology is a registered trademark of Microchip Technology Inc. in other countries.

Analog-for-the-Digital Age, Application Maestro, BodyCom, chipKIT, chipKIT logo, CodeGuard, dsPICDEM, dsPICDEM.net, dsPICworks, dsSPEAK, ECAN, ECONOMONITOR, FanSense, HI-TIDE, In-Circuit Serial Programming, ICSP, Mindi, MiWi, MPASM, MPF, MPLAB Certified logo, MPLIB, MPLINK, mTouch, Omniscient Code Generation, PICC, PICC-18, PICDEM, PICDEM.net, PICkit, PICtail, REAL ICE, rfLAB, Select Mode, SQI, Serial Quad I/O, Total Endurance, TSHARC, UniWinDriver, WiperLock, ZENA and Z-Scale are trademarks of Microchip Technology Incorporated in the U.S.A. and other countries.

SQTP is a service mark of Microchip Technology Incorporated in the U.S.A.

GestIC and ULPP are registered trademarks of Microchip Technology Germany II GmbH & Co. KG, a subsidiary of Microchip Technology Inc., in other countries.

All other trademarks mentioned herein are property of their respective companies.

© 2010-2014, Microchip Technology Incorporated, Printed in the U.S.A., All Rights Reserved.

Printed on recycled paper.

ISBN: 978-1-63276-052-4

Microchip received ISO/TS-16949:2009 certification for its worldwide headquarters, design and wafer fabrication facilities in Chandler and Tempe, Arizona; Gresham, Oregon and design centers in California and India. The Company's quality system processes and procedures are for its PIC® MCUs and dsPIC® DSCs, KEELOQ® code hopping devices, Serial EEPROMs, microperipherals, nonvolatile memory and analog products. In addition, Microchip's quality system for the design and mulfacture of development systems is ISO 9001:2000 certified.



Worldwide Sales and Service

AMERICAS

Corporate Office 2355 West Chandler Blvd. Chandler, AZ 85224-6199 Tel: 480-792-7200 Fax: 480-792-7277 Technical Support: http://www.microchip.com/ support

Web Address: www.microchip.com

Atlanta Duluth, GA Tel: 678-957-9614 Fax: 678-957-1455

Austin, TX Tel: 512-257-3370

Boston Westborough, MA Tel: 774-760-0087 Fax: 774-760-0088

Chicago Itasca, IL Tel: 630-285-0071 Fax: 630-285-0075

Cleveland Independence, OH Tel: 216-447-0464 Fax: 216-447-0643

Dallas Addison, TX Tel: 972-818-7423 Fax: 972-818-2924

Detroit Novi, MI Tel: 248-848-4000

Houston, TX Tel: 281-894-5983

Indianapolis Noblesville, IN Tel: 317-773-8323 Fax: 317-773-5453

Los Angeles Mission Viejo, CA Tel: 949-462-9523 Fax: 949-462-9608

New York, NY Tel: 631-435-6000

San Jose, CA Tel: 408-735-9110

Canada - Toronto Tel: 905-673-0699 Fax: 905-673-6509

ASIA/PACIFIC

Asia Pacific Office Suites 3707-14, 37th Floor Tower 6, The Gateway Harbour City, Kowloon Hong Kong Tel: 852-2943-5100 Fax: 852-2401-3431

Australia - Sydney Tel: 61-2-9868-6733 Fax: 61-2-9868-6755

China - Beijing Tel: 86-10-8569-7000 Fax: 86-10-8528-2104

China - Chengdu Tel: 86-28-8665-5511 Fax: 86-28-8665-7889

China - Chongqing Tel: 86-23-8980-9588 Fax: 86-23-8980-9500

China - Hangzhou Tel: 86-571-8792-8115 Fax: 86-571-8792-8116

China - Hong Kong SAR Tel: 852-2943-5100

Fax: 852-2401-3431

China - Nanjing Tel: 86-25-8473-2460 Fax: 86-25-8473-2470

China - Qingdao Tel: 86-532-8502-7355 Fax: 86-532-8502-7205

China - Shanghai Tel: 86-21-5407-5533 Fax: 86-21-5407-5066

China - Shenyang Tel: 86-24-2334-2829 Fax: 86-24-2334-2393

China - Shenzhen Tel: 86-755-8864-2200 Fax: 86-755-8203-1760

China - Wuhan Tel: 86-27-5980-5300 Fax: 86-27-5980-5118

China - Xian Tel: 86-29-8833-7252 Fax: 86-29-8833-7256

China - Xiamen Tel: 86-592-2388138 Fax: 86-592-2388130

China - Zhuhai Tel: 86-756-3210040 Fax: 86-756-3210049

ASIA/PACIFIC

India - Bangalore Tel: 91-80-3090-4444 Fax: 91-80-3090-4123

India - New Delhi Tel: 91-11-4160-8631 Fax: 91-11-4160-8632

India - Pune Tel: 91-20-3019-1500

Japan - Osaka Tel: 81-6-6152-7160 Fax: 81-6-6152-9310

Japan - Tokyo Tel: 81-3-6880- 3770 Fax: 81-3-6880-3771

Korea - Daegu Tel: 82-53-744-4301 Fax: 82-53-744-4302

Korea - Seoul Tel: 82-2-554-7200 Fax: 82-2-558-5932 or 82-2-558-5934

Malaysia - Kuala Lumpur Tel: 60-3-6201-9857 Fax: 60-3-6201-9859

Malaysia - Penang Tel: 60-4-227-8870 Fax: 60-4-227-4068

Philippines - Manila Tel: 63-2-634-9065 Fax: 63-2-634-9069

Singapore Tel: 65-6334-8870 Fax: 65-6334-8850

Taiwan - Hsin Chu Tel: 886-3-5778-366 Fax: 886-3-5770-955

Taiwan - Kaohsiung Tel: 886-7-213-7830

Taiwan - Taipei Tel: 886-2-2508-8600 Fax: 886-2-2508-0102

Thailand - Bangkok Tel: 66-2-694-1351 Fax: 66-2-694-1350

EUROPE

Austria - Wels Tel: 43-7242-2244-39 Fax: 43-7242-2244-393 Denmark - Copenhagen Tel: 45-4450-2828 Fax: 45-4485-2829

France - Paris Tel: 33-1-69-53-63-20 Fax: 33-1-69-30-90-79

Germany - Dusseldorf Tel: 49-2129-3766400

Germany - Munich Tel: 49-89-627-144-0 Fax: 49-89-627-144-44

Germany - Pforzheim Tel: 49-7231-424750

Italy - Milan Tel: 39-0331-742611 Fax: 39-0331-466781

Italy - Venice Tel: 39-049-7625286

Netherlands - Drunen Tel: 31-416-690399 Fax: 31-416-690340

Poland - Warsaw Tel: 48-22-3325737

Spain - Madrid Tel: 34-91-708-08-90 Fax: 34-91-708-08-91

Sweden - Stockholm Tel: 46-8-5090-4654

UK - Wokingham Tel: 44-118-921-5800 Fax: 44-118-921-5820

03/25/14